SYNCHRONOUS DRAM

MT48LC1M16A1 S - 512K x 16 x 2 banks

For the latest data sheet, please refer to the Micron Web site: www.micronsemi.com/datasheets/sdramds.html

FEATURES

- PC100 functionality
- Fully synchronous; all signals registered on positive edge of system clock
- Internal pipelined operation; column address can be changed every clock cycle
- Internal banks for hiding row access/precharge
  1 Meg x 16 - 512K x 16 x 2 banks architecture with 11 row, 8 column addresses per bank
- Programmable burst lengths: 1, 2, 4, 8 or full page
- Auto Precharge Mode, includes CONCURRENT AUTO PRECHARGE
- Self Refresh and Adaptable Auto Refresh Modes
  - 32ms, 2,048-cycle refresh or
  - 64ms, 2,048-cycle refresh or
  - 64ms, 4,096-cycle refresh
- LVTTL-compatible inputs and outputs
- Single +3.3V ±0.3V power supply
- Supports CAS latency of 1, 2 and 3

OPTIONS — MARKING

- Configuration
  1 Meg x 16 (512K x 16 x 2 banks) — 1M16A1
- Plastic Package - OCPL*
  50-pin TSOP (400 mil) — TG
- Timing (Cycle Time)
  6ns (166 MHz) — -6
  7ns (143 MHz) — -7
  8ns (125 MHz) — -8A
- Refresh
  2K or 4K with Self Refresh Mode at 64ms — S

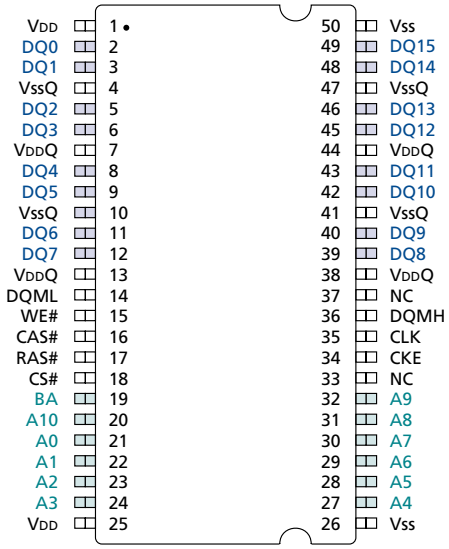
Part Number Example:
MT48LC1M16A1TG-7S

KEY TIMING PARAMETERS

SPEED	CLOCK	ACCESS TIME CL = 3**	SETUP	HOLD
-6	166 MHz	5.5ns	2ns	1ns
-7	143 MHz	5.5ns	2ns	1ns
-8A	125 MHz	6ns	2ns	1ns

*Off-center parting line
**CL = CAS (READ) latency

PIN ASSIGNMENT (Top View)
50-Pin TSOP



Note: The # symbol indicates signal is active LOW.

	1 Meg x 16
Configuration	512K x 16 x 2 banks
Refresh Count	2K or 4K
Row Addressing	2K (A0-A10)
Bank Addressing	2 (BA)
Column Addressing	256 (A0-A7)

16MB (X16) SDRAM PART NUMBER

PART NUMBER	ARCHITECTURE
MT48LC1M16A1TG S	1 Meg x 16

GENERAL DESCRIPTION

The 16Mb SDRAM is a high-speed CMOS, dynamic random-access memory containing 16,777,216 bits. It is internally configured as a dual 512K x 16 DRAM with a synchronous interface (all signals are registered on the positive edge of the clock signal, CLK). Each of the 512K x 16-bit banks is organized as 2,048 rows by 256 columns by 16 bits. Read and write accesses to the SDRAM are burst oriented; accesses start at a selected location and continue for a programmed number of

GENERAL DESCRIPTION (continued)

locations in a programmed sequence. Accesses begin with the registration of an ACTIVE command, which is then followed by a READ or WRITE command. The address bits registered coincident with the ACTIVE command are used to select the bank and row to be accessed (BA selects the bank, A0-A10 select the row). The address bits registered coincident with the READ or WRITE command are used to select the starting column location for the burst access.

The SDRAM provides for programmable READ or WRITE burst lengths of 1, 2, 4 or 8 locations, or the full page, with a burst terminate option. An AUTO PRECHARGE function may be enabled to provide a self-timed row precharge that is initiated at the end of the burst sequence.

The 1 Meg x 16 SDRAM uses an internal pipelined architecture to achieve high-speed operation. This architecture is compatible with the 2*n* rule of prefetch architectures, but it also allows the column address to be changed on every clock cycle to achieve a high-speed, fully random access. Precharging one bank while accessing the alternate bank will hide the PRECHARGE cycles and provide seamless, high-speed, random-access operation.

The 1 Meg x 16 SDRAM is designed to operate in 3.3V, low-power memory systems. An auto refresh mode is provided, along with a power-saving, power-down mode. All inputs and outputs are LVTTL-compatible.

SDRAMs offer substantial advances in DRAM operating performance, including the ability to synchronously burst data at a high data rate with automatic column-address generation, the ability to interleave between internal banks in order to hide precharge time, and the capability to randomly change column addresses on each clock cycle during a burst access.

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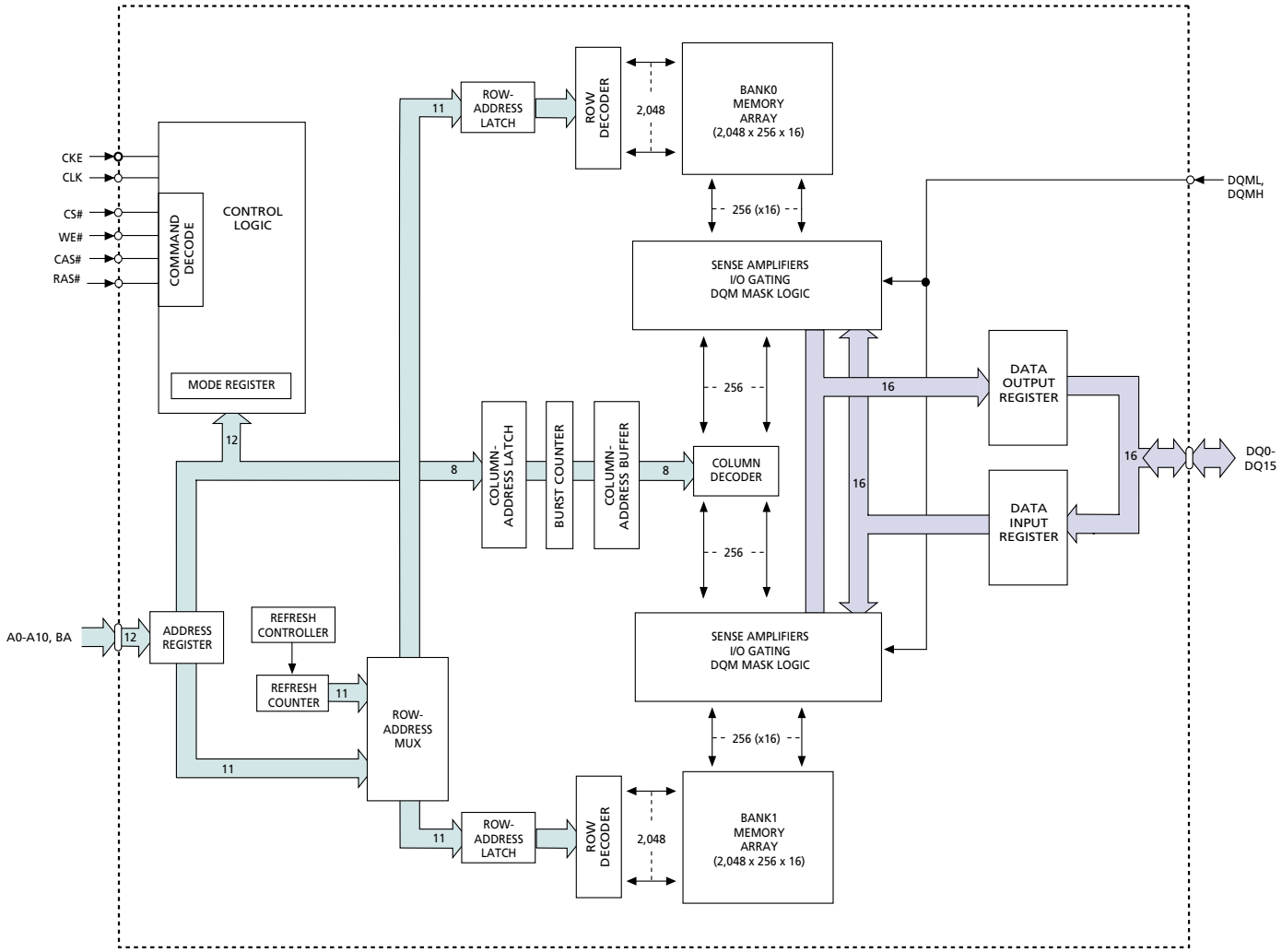
FUNCTIONAL BLOCK DIAGRAM
1 Meg x 16 SDRAM



PIN DESCRIPTIONS

PIN NUMBERS	SYMBOL	TYPE	DESCRIPTION
35	CLK	Input	Clock: CLK is driven by the system clock. All SDRAM input signals are sampled on the positive edge of CLK. CLK also increments the internal burst counter and controls the output registers.
34	CKE	Input	Clock Enable: CKE activates (HIGH) and deactivates (LOW) the CLK signal. Deactivating the clock provides PRECHARGE POWER-DOWN and SELF REFRESH operations (all banks idle), ACTIVE POWER-DOWN (row ACTIVE in either bank) or CLOCK SUSPEND operation (burst/access in progress). CKE is synchronous except after the device enters power-down and self refresh modes, where CKE becomes asynchronous until after exiting the same mode. The input buffers, including CLK, are disabled during power-down and self refresh modes, providing low standby power. CKE may be tied HIGH.
18	CS#	Input	Chip Select: CS# enables (registered LOW) and disables (registered HIGH) the command decoder. All commands are masked when CS# is registered HIGH. CS# provides for external bank selection on systems with multiple banks. CS# is considered part of the command code.
15, 16, 17	WE#, CAS#, RAS#	Input	Command Inputs: RAS#, CAS# and WE# (along with CS#) define the command being entered.
14, 36	DQML, DQMH	Input	Input/Output Mask: DQM is an input mask signal for write accesses and an output enable signal for read accesses. Input data is masked when DQM is sampled HIGH during a WRITE cycle. The output buffers are placed in a High-Z state (two-clock latency) when DQM is sampled HIGH during a READ cycle. DQML corresponds to DQ0-DQ7; DQMH corresponds to DQ8-DQ15. DQML and DQMH are considered same state when referenced as DQM.
19	BA	Input	Bank Address Inputs: BA defines to which bank the ACTIVE, READ, WRITE or PRECHARGE command is being applied. BA is also used to program the twelfth bit of the Mode Register.
21-24, 27-32, 20	A0-A10	Input	Address Inputs: A0-A10 are sampled during the ACTIVE command (row-address A0-A10) and READ/WRITE command (column-address A0-A7, with A10 defining AUTO PRECHARGE) to select one location out of the 512K available in the respective bank. A10 is sampled during a PRECHARGE command to determine if all banks are to be precharged (A10 HIGH). The address inputs also provide the op-code during a LOAD MODE REGISTER command.
2, 3, 5, 6, 8, 9, 11, 12, 39, 40, 42, 43, 45, 46, 48, 49	DQ0-DQ15	Input/ Output	Data I/Os: Data bus.
33, 37	NC	–	No Connect: These pins should be left unconnected.
7, 13, 38, 44	$V_{DD}Q$	Supply	DQ Power: Provide isolated power to DQs for improved noise immunity.
4, 10, 41, 47	$V_{SS}Q$	Supply	DQ Ground: Provide isolated ground to DQs for improved noise immunity.
1, 25	V_{DD}	Supply	Power Supply: +3.3V ±0.3V.
26, 50	V_{SS}	Supply	Ground.

FUNCTIONAL DESCRIPTION

In general, the SDRAM is a dual 512K x 16 DRAM that operates at 3.3V and includes a synchronous interface (all signals are registered on the positive edge of the clock signal, CLK). Each of the 512K x 16-bit banks is organized as 2,048 rows by 256 columns by 16 bits.

Read and write accesses to the SDRAM are burst oriented; accesses start at a selected location and continue for a programmed number of locations in a programmed sequence. Accesses begin with the registration of an ACTIVE command, which is then followed by a READ or WRITE command. The address bits registered coincident with the ACTIVE command are used to select the bank and row to be accessed (BA selects the bank, A0-A10 select the row). The address bits (A0-A7) registered coincident with the READ or WRITE command are used to select the starting column location for the burst access.

Prior to normal operation, the SDRAM must be initialized. The following sections provide detailed information covering device initialization, register definition, command descriptions and device operation.

Initialization

SDRAMs must be powered up and initialized in a predefined manner. Operational procedures other than those specified may result in undefined operation. Once power is applied to V_{DD} and $V_{DD}Q$ (simultaneously) and the clock is stable (stable clock is defined as a signal cycling within timing constraints specified for the clock pin), the SDRAM requires a 100µs delay prior to applying any command other than a COMMAND INHIBIT or a NOP. Starting at some point during this 100µs period and continuing at least through the end of this period, COMMAND INHIBIT or NOP commands should be applied.

Once the 100µs delay has been satisfied, with at least one COMMAND INHIBIT or NOP command having been applied, a PRECHARGE command should be applied. All banks must then be precharged, thereby placing the device in the all banks idle state.

Once in the idle state, two AUTO REFRESH cycles must be performed. After the AUTO REFRESH cycles are complete, the SDRAM is ready for Mode Register programming. Because the Mode Register will power up in an unknown state, it should be loaded prior to applying any operational command.

REGISTER DEFINITION

MODE REGISTER

The Mode Register is used to define the specific mode of operation of the SDRAM. This definition includes the selection of a burst length, a burst type, a CAS latency, an operating mode and a write burst mode, as shown in Figure 1. The Mode Register is programmed via the LOAD MODE REGISTER command and will retain the stored information until it is programmed again or the device loses power.

Mode Register bits M0-M2 specify the burst length, M3 specifies the type of burst (sequential or interleaved), M4-M6 specify the CAS latency, M7 and M8 specify the operating mode, M9 specifies the write burst mode, and M10 and M11 are reserved for future use.

The Mode Register must be loaded when all banks are idle, and the controller must wait the specified time before initiating the subsequent operation. Violating either of these requirements will result in unspecified operation.

Burst Length

Read and write accesses to the SDRAM are burst oriented, with the burst length being programmable, as shown in Figure 1. The burst length determines the maximum number of column locations that can be accessed for a given READ or WRITE command. Burst lengths of 1, 2, 4 or 8 locations are available for both the sequential and the interleaved burst types, and a full-page burst is available for the sequential type. The full-page burst is used in conjunction with the BURST TERMINATE command to generate arbitrary burst lengths.

Reserved states should not be used, as unknown operation or incompatibility with future versions may result.

When a READ or WRITE command is issued, a block of columns equal to the burst length is effectively selected. All accesses for that burst take place within this block, meaning that the burst will wrap within the block if a boundary is reached. The block is uniquely selected by A1-A7 when the burst length is set to two, by A2-A7 when the burst length is set to four and by A3-A7 when the burst length is set to eight. The remaining (least significant) address bit(s) is (are) used to select the starting location within the block. Full-page bursts wrap within the page if the boundary is reached.

Burst Type

Accesses within a given burst may be programmed to be either sequential or interleaved; this is referred to as the burst type and is selected via bit M3.

The ordering of accesses within a burst is determined by the burst length, the burst type and the starting column address, as shown in Table 1.

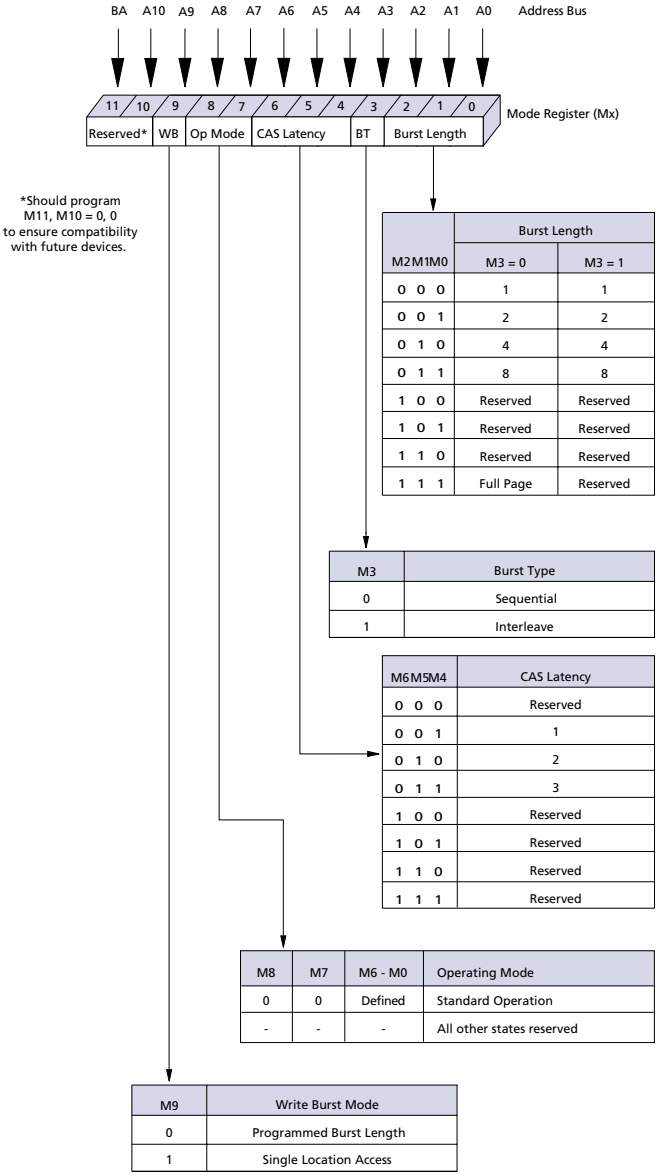


Figure 1
Mode Register Definition

Table 1
Burst Definition

Burst Length	Starting Column Address	Order of Accesses Within a Burst	
		Type = Sequential	Type = Interleaved
2	A0		
	0	0-1	0-1
	1	1-0	1-0
4	A1 A0		
	0 0	0-1-2-3	0-1-2-3
	0 1	1-2-3-0	1-0-3-2
	1 0	2-3-0-1	2-3-0-1
	1 1	3-0-1-2	3-2-1-0
8	A2 A1 A0		
	0 0 0	0-1-2-3-4-5-6-7	0-1-2-3-4-5-6-7
	0 0 1	1-2-3-4-5-6-7-0	1-0-3-2-5-4-7-6
	0 1 0	2-3-4-5-6-7-0-1	2-3-0-1-6-7-4-5
	0 1 1	3-4-5-6-7-0-1-2	3-2-1-0-7-6-5-4
	1 0 0	4-5-6-7-0-1-2-3	4-5-6-7-0-1-2-3
	1 0 1	5-6-7-0-1-2-3-4	5-4-7-6-1-0-3-2
	1 1 0	6-7-0-1-2-3-4-5	6-7-4-5-2-3-0-1
	1 1 1	7-0-1-2-3-4-5-6	7-6-5-4-3-2-1-0
Full Page (256)	n = A0-A7 (location 0-255)	Cn, Cn+1, Cn+2 Cn+3, Cn+4... ...Cn-1, Cn...	Not supported

NOTE:
1. For a burst length of two, A1-A7 select the block of two burst; A0 selects the starting column within the block.
2. For a burst length of four, A2-A7 select the block of four burst; A0-A1 select the starting column within the block.
3. For a burst length of eight, A3-A7 select the block of eight burst; A0-A2 select the starting column within the block.
4. For a full-page burst, the full row is selected and A0-A7 select the starting column.
5. Whenever a boundary of the block is reached within a given sequence above, the following access wraps within the block.
6. For a burst length of one, A0-A7 select the unique column to be accessed, and Mode Register bit M3 is ignored.

CAS Latency

The CAS latency is the delay, in clock cycles, between the registration of a READ command and the availability of the first piece of output data. The latency can be set to 1, 2 or 3 clocks.

If a READ command is registered at clock edge *n*, and the latency is *m* clocks, the data will be available by clock edge *n* + *m*. The DQs will start driving as a result of the clock edge one cycle earlier (*n* + *m* - 1), and provided that the relevant access times are met, the data will be valid by clock edge *n* + *m*. For example, assuming that the clock cycle time is such that all relevant access times are met, if a READ command is registered at T0, and the latency is programmed to two clocks, the DQs will start driving after T1 and the data will be valid by T2, as shown in Figure 2. Table 2 below indicates the operating frequencies at which each CAS latency setting can be used.

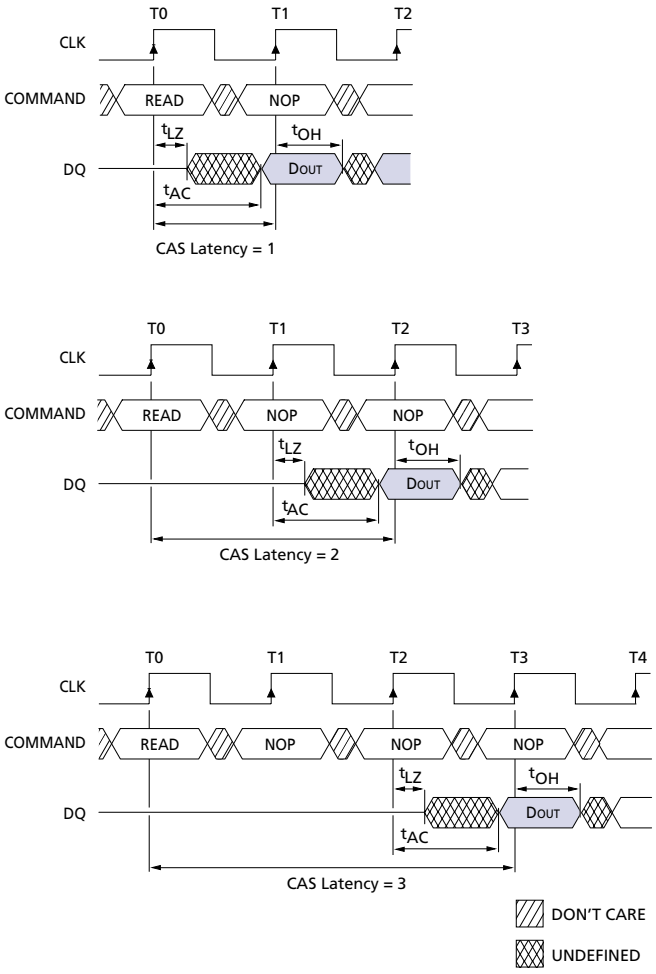


Figure 2
CAS Latency

Reserved states should not be used, as unknown operation or incompatibility with future versions may result.

Operating Mode

The normal operating mode is selected by setting M7 and M8 to zero; the other combinations of values for M7 and M8 are reserved for future use and/or test modes. The programmed burst length applies to both READ and WRITE bursts.

Test modes and reserved states should not be used because unknown operation or incompatibility with future versions may result.

Write Burst Mode

When M9 = 0, the burst length programmed via M0-M2 applies to both READ and WRITE bursts; when M9 = 1, the programmed burst length applies to READ bursts, but write accesses are single-location (nonburst) accesses.

Table 2
CAS Latency

SPEED	ALLOWABLE OPERATING FREQUENCY (MHz)		
	CAS LATENCY = 1	CAS LATENCY = 2	CAS LATENCY = 3
-6	≤ 50	≤ 125	≤ 166
-7	≤ 40	≤ 100	≤ 143
-8A	≤ 40	≤ 77	≤ 125

COMMANDS

Truth Table 1 provides a quick reference of available commands. This is followed by a written description of each command. Three additional Truth Tables appear following the Operation section; these tables provide current state/next state information.

TRUTH TABLE 1 – COMMANDS AND DQM OPERATION

(Notes: 1)

NAME (FUNCTION)	CS#	RAS#	CAS#	WE#	DQM	ADDR	DQs	NOTES
COMMAND INHIBIT (NOP)	H	X	X	X	X	X	X	
NO OPERATION (NOP)	L	H	H	H	X	X	X	
ACTIVE (Select bank and activate row)	L	L	H	H	X	Bank/Row	X	3
READ (Select bank and column and start READ burst)	L	H	L	H	L/H[8]	Bank/Col	X	4
WRITE (Select bank and column and start WRITE burst)	L	H	L	L	L/H[8]	Bank/Col	Valid	4
BURST TERMINATE	L	H	H	L	X	X	Active	
PRECHARGE (Deactivate row in bank or banks)	L	L	H	L	X	Code	X	5
AUTO REFRESH or SELF REFRESH (Enter self refresh mode)	L	L	L	H	X	X	X	6, 7
LOAD MODE REGISTER	L	L	L	L	X	Op-Code	X	2
Write Enable/Output Enable	–	–	–	–	L	–	Active	8
Write Inhibit/Output High-Z	–	–	–	–	H	–	High-Z	8

NOTE:
1. CKE is HIGH for all commands shown except SELF REFRESH.
2. A0-A10 and BA define the op-code written to the Mode Register.
3. A0-A10 provide row address, and BA determines which bank is made active.
4. A0-A7 provide column address; A10 HIGH enables the auto precharge feature (nonpersistent), while A10 LOW disables the auto precharge feature; BA determines which bank is being read from or written to.
5. For A10 LOW, BA determines which bank is being precharged; for A10 HIGH, all banks are precharged and BA is a "Don't Care."
6. This command is AUTO REFRESH if CKE is HIGH, SELF REFRESH if CKE is LOW.
7. Internal refresh counter controls row addressing; all inputs and I/Os are "Don't Care" except for CKE.
8. Activates or deactivates the DQs during WRITEs (zero-clock delay) and READs (two-clock delay).

COMMAND INHIBIT

The COMMAND INHIBIT function prevents new commands from being executed by the SDRAM, regardless of whether the CLK signal is enabled. The SDRAM is effectively deselected. Operations already in progress are not affected.

NO OPERATION (NOP)

The NO OPERATION (NOP) command is used to perform a NOP to an SDRAM which is selected (CS# is LOW). This prevents unwanted commands from being registered during idle or wait states. Operations already in progress are not affected.

LOAD MODE REGISTER

The Mode Register is loaded via inputs A0-A10 and BA. See Mode Register heading in Register Definition section. The LOAD MODE REGISTER command can only be issued when all banks are idle, and a subsequent executable command cannot be issued until ^{t}MRD is met.

ACTIVE

The ACTIVE command is used to open (or activate) a row in a particular bank for a subsequent access. The value on the BA input selects the bank, and the address provided on inputs A0-A10 selects the row. This row remains active (or open) for accesses until a PRECHARGE command is issued to that bank. A PRECHARGE command must be issued before opening a different row in the same bank.

READ

The READ command is used to initiate a burst read access to an active row. The value on the BA input selects the bank, and the address provided on inputs A0-A7 selects the starting column location. The value on input A10 determines whether or not AUTO PRECHARGE is used. If AUTO PRECHARGE is selected, the row being accessed will be precharged at the end of the READ burst; if AUTO PRECHARGE is not selected, the row will remain open for subsequent accesses. Read data appears on the DQs, subject to the logic level on the DQM inputs two clocks earlier. If a given DQM signal was registered HIGH, the corresponding DQs will be High-Z two clocks later; if the DQM signal was registered LOW, the DQs will provide valid data.

WRITE

The WRITE command is used to initiate a burst write access to an active row. The value on the BA input selects the bank, and the address provided on inputs A0-A7 selects the starting column location. The value on input A10 determines whether or not AUTO PRECHARGE is used. If AUTO PRECHARGE is selected, the row being accessed will be precharged at the end of the WRITE burst; if AUTO PRECHARGE is not selected, the row will remain open for subsequent accesses. Input data appearing on the DQs is written to the memory array subject to the DQM input logic level appearing coincident with the data. If a given DQM signal is registered LOW, the corresponding data will be written to memory; if the DQM signal is registered HIGH, the corresponding data inputs will be ignored, and a WRITE will not be executed to that byte/column location.

PRECHARGE

The PRECHARGE command is used to deactivate the open row in a particular bank or the open row in all banks. The bank(s) will be available for a subsequent row access a specified time (^{t}RP) after the PRECHARGE command is issued. Input A10 determines whether one or all banks are to be precharged, and in the case where only one bank is to be precharged, input BA selects the bank. Otherwise BA is treated as “Don’t Care.” Once a bank has been precharged, it is in the idle state and must be activated prior to any READ or WRITE commands being issued to that bank.

AUTO PRECHARGE

AUTO PRECHARGE is a feature which performs the same individual-bank PRECHARGE function described above, but without requiring an explicit command. This is accomplished by using A10 to enable AUTO PRECHARGE in conjunction with a specific READ or WRITE command. A precharge of the bank/row that is addressed with the READ or WRITE command is automatically performed upon completion of the READ or WRITE burst, except in the full-page burst mode, where AUTO PRECHARGE does not apply. AUTO PRECHARGE is nonpersistent in that it is either enabled or disabled for each individual READ or WRITE command.

AUTO PRECHARGE ensures that the PRECHARGE is initiated at the earliest valid stage within a burst. The user must not issue another command to the same bank until the precharge time (^{t}RP) is completed. This is determined as if an explicit PRECHARGE command was issued at the earliest possible time, as described for each burst type in the Operation section of this data sheet.

BURST TERMINATE

The BURST TERMINATE command is used to truncate either fixed-length or full-page bursts. The most recently registered READ or WRITE command prior to the BURST TERMINATE command will be truncated as shown in the Operation section of this data sheet.

AUTO REFRESH

AUTO REFRESH is used during normal operation of the SDRAM and is analogous to CAS#-BEFORE-RAS# (CBR) REFRESH in conventional DRAMs. This command is nonpersistent, so it must be issued each time a refresh is required.

The addressing during an AUTO REFRESH command is generated by an internal refresh controller. This means that the address lines are not used to generate the refresh address, and are "Don't Care".

The 1 Meg x 16 SDRAM requires 2,048 AUTO REFRESH cycles every 64ms (^{t}REF) to ensure that each row is refreshed. Distributed refresh would be achieved by providing an AUTO REFRESH command once every 31.25µs. Burst refresh could be accomplished by issuing 2,048 AUTO REFRESH commands consecutively at the minimum cycle rate of ^{t}RC.

To provide a 4K refresh scheme, the refresh rate would be doubled. Thus, 2,048 AUTO-REFRESH commands distributed every 15.625µs would allow the 1 Meg x 16 SDRAM to have a 4K refresh if required. Of the three types of refreshs options, utilizing the 2,048 cycles every 64ms (31.25µs per refresh) provides the maximum power savings.

SELF REFRESH

The SELF REFRESH command can be used to retain data in the SDRAM, even if the rest of the system is powered down. When in the self refresh mode, the SDRAM retains data without external clocking. The SELF REFRESH command is initiated like an AUTO REFRESH command except CKE is disabled (LOW). Once the SELF REFRESH command is registered, all the inputs to the SDRAM become "Don't Care," with the exception of CKE, which must remain LOW.

Once self refresh mode is engaged, the SDRAM provides its own internal clocking, causing it to perform its own auto refresh cycles. The SDRAM must remain in self refresh mode for a minimum period equal to ^{t}RAS, and may remain in self refresh mode for an indefinite period beyond that.

The procedure for exiting self refresh requires a sequence of commands. First, CLK must be stable (stable clock is defined as a signal cycling within timing constraints specified for the clock pin) prior to CKE going back HIGH. Once CKE is HIGH, the SDRAM must have NOP commands issued (a minimum of two clocks) for ^{t}XSR, because time is required for the completion of any internal refresh in progress.

Upon exiting self refresh mode, AUTO REFRESH commands may be issued every 15.625µs or less as both SELF REFRESH and AUTO REFRESH utilize the row refresh counter.

OPERATION

BANK/ROW ACTIVATION

Before any READ or WRITE commands can be issued to a bank within the SDRAM, a row in that bank must be "opened." This is accomplished via the ACTIVE command, which selects both the bank and the row to be activated (see Figure 3).

After opening a row (issuing an ACTIVE command) a READ or WRITE command may be issued to that row, subject to the ^{t}RCD specification. ^{t}RCD (MIN) should be divided by the clock period and rounded up to the next whole number to determine the earliest clock edge after the ACTIVE command on which a READ or WRITE command can be issued. For example, a ^{t}RCD specification of 20ns with a 125 MHz clock (8ns period) results in 2.5 clocks rounded to 3. This is reflected in Figure 4, which covers any case where 2 < ^{t}RCD (MIN)/^{t}CK ≤ 3. (The same procedure is used to convert other specification limits from time units to clock cycles.)

A subsequent ACTIVE command to a different row in the same bank can only be issued after the previous active row has been "closed" (precharged). The minimum time interval between successive ACTIVE commands to the same bank is defined by ^{t}RC.

A subsequent ACTIVE command to another bank can be issued while the first bank is being accessed, which results in a reduction of total row access overhead. The minimum time interval between successive ACTIVE commands to different banks is defined by ^{t}RRD.

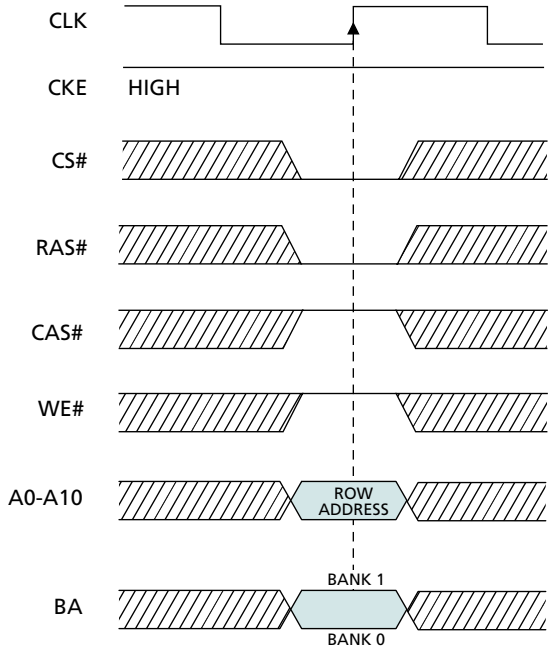


Figure 3
Activating a Specific Row in a Specific Bank

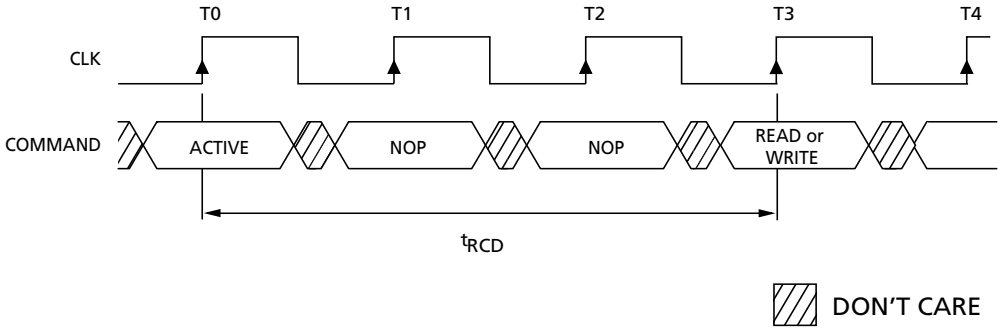


Figure 4
Example: Meeting ^{t}RCD (MIN) When 2 < ^{t}RCD (MIN)/^{t}CK ≤ 3

READS

READ bursts are initiated with a READ command, as shown in Figure 5.

The starting column and bank addresses are provided with the READ command and AUTO PRECHARGE is either enabled or disabled for that burst access. If AUTO PRECHARGE is enabled, the row being accessed is precharged at the completion of the burst. For the generic READ commands used in the following illustrations, AUTO PRECHARGE is disabled.

During READ bursts, the valid data-out element from the starting column address will be available following the CAS latency after the READ command. Each subsequent data-out element will be valid by the next positive clock edge. Figure 6 shows general timing for each possible CAS latency setting.

Upon completion of a burst, assuming no other commands have been initiated, the DQs will go High-Z. A full-page burst will continue until terminated (at the end of the page it will wrap to column 0 and continue).

Data from any READ burst may be truncated with a subsequent READ command, and data from a fixed-length READ burst may be immediately followed by data from a subsequent READ command. In either case, a continuous flow of data can be maintained. The first data element from the new burst follows either the last element of a completed burst, or the last desired data element of a longer burst which is being truncated. The new READ command should be issued *x* cycles before the clock edge at which the last desired

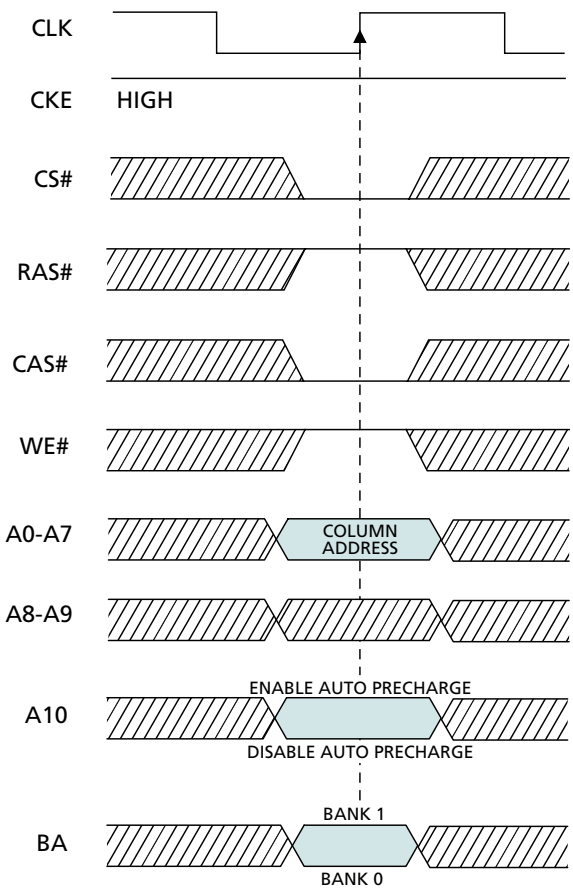


Figure 5
READ Command

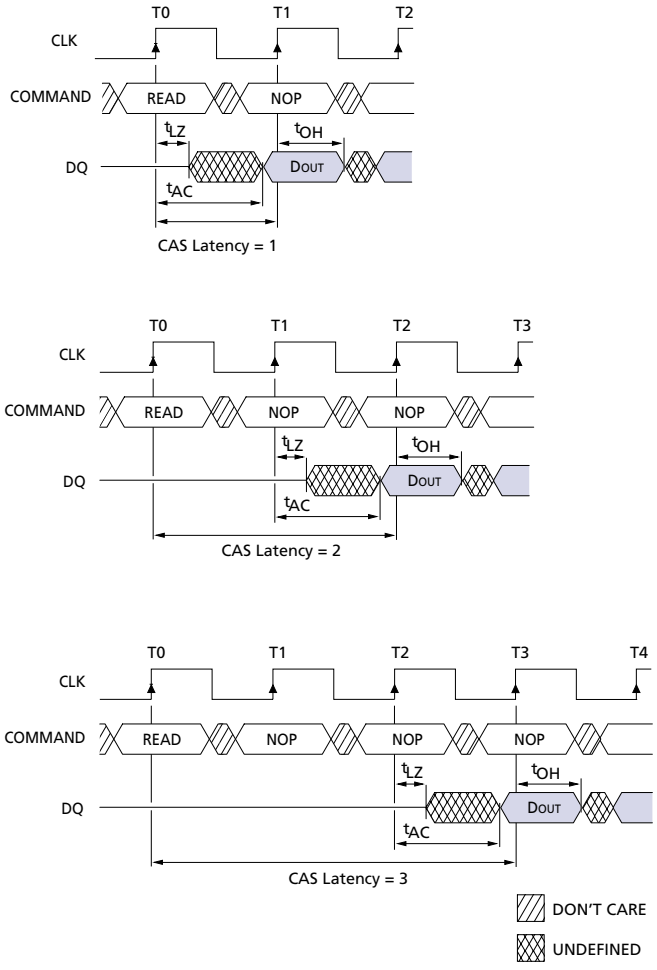


Figure 6
CAS Latency

data element is valid, where *x* equals the CAS latency minus one. This is shown in Figure 7 for READ latencies of one, two and three; data element *n* + 3 is either the last of a burst of four or the last desired of a longer burst. The 1 Meg x 16 SDRAM uses a pipelined architecture and therefore does not require the 2*n* rule associated with a prefetch architecture. A READ command can be initiated on any clock cycle following a previous READ command. Full-speed, random read accesses within a page can be performed as shown in Figure 8.

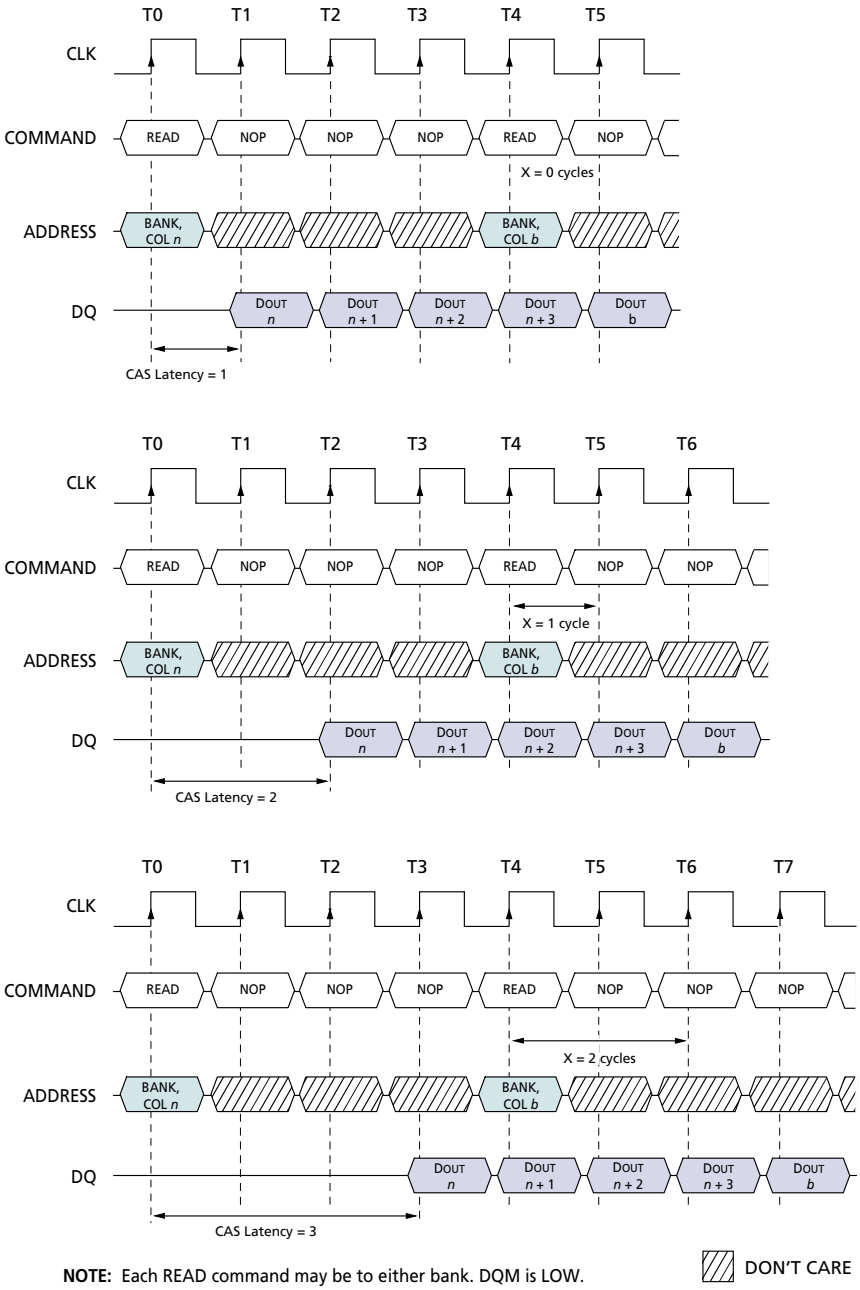
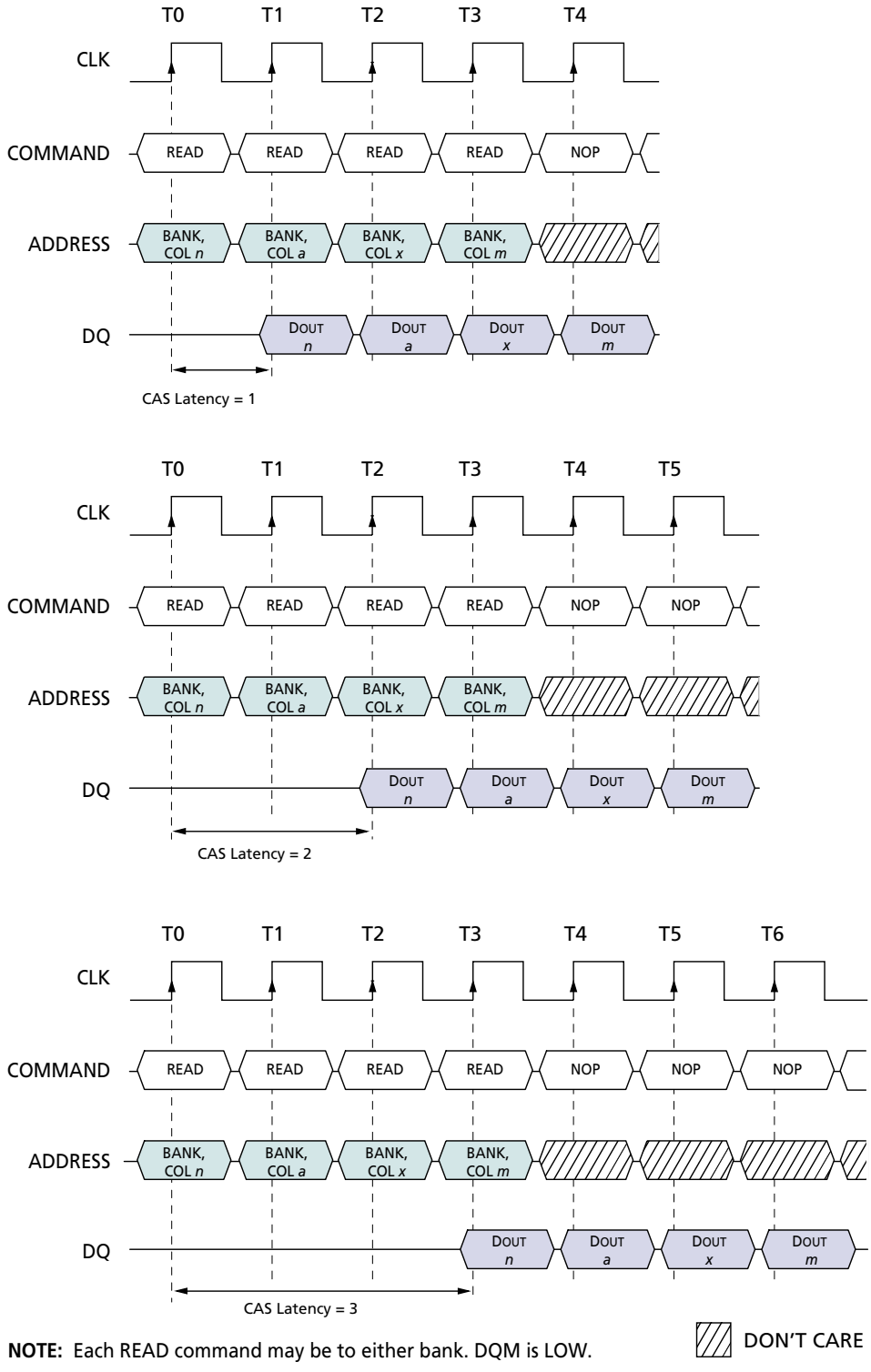


Figure 7
Consecutive READ Bursts



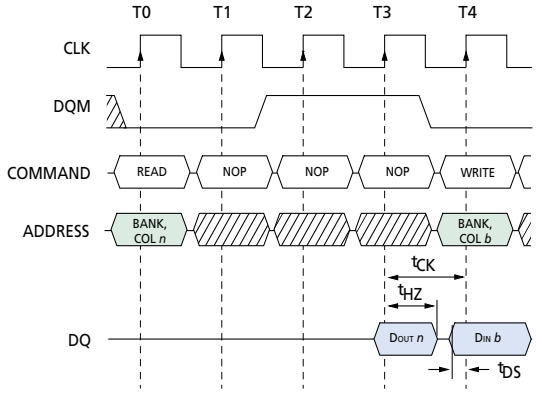
NOTE: Each READ command may be to either bank. DQM is LOW.

Figure 8
Random READ Accesses

Data from any READ burst may be truncated with a subsequent WRITE command, and data from a fixed-length READ burst may be immediately followed by data from a subsequent WRITE command (subject to bus turnaround limitations). The WRITE burst may be initiated on the clock edge immediately following the last (or last desired) data element from the READ burst, provided that I/O contention can be avoided. In a given system design, there may be the possibility that the device driving the input data would go Low-Z before the SDRAM DQs go High-Z. In this case, at least a single-cycle delay should occur between the last read data and the WRITE command.

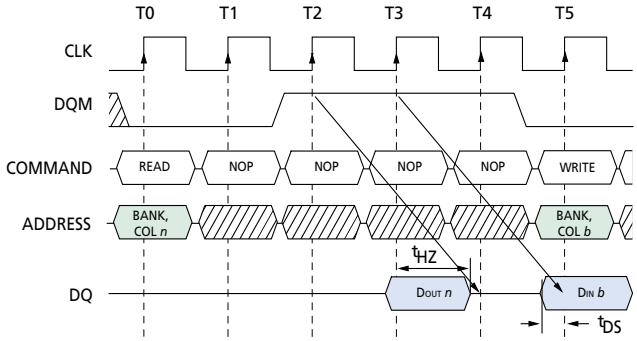
The DQM input is used to avoid I/O contention as shown in Figures 9 and 10. The DQM signal must be asserted (HIGH) at least two clocks (DQM latency is two clocks for output buffers) prior to the WRITE command to suppress data-out from the READ. Once the WRITE command is registered, the DQs will go High-Z (or remain High-Z) regardless of the state of the DQM signal, provided the DQM was active on the clock just prior to the WRITE command that truncated the READ command. If not, the second WRITE will be an invalid WRITE. For example, if DQM was LOW during T4 in Figure 10, then the WRITEs at T5 and T7 would be valid, while the WRITE at T6 would be invalid.

The DQM signal must be de-asserted (DQM latency is zero clocks for input buffers) prior to the WRITE command to ensure that the written data is not masked. Figure 9 shows the case where the clock frequency allows for bus contention to be avoided without adding a NOP cycle, and Figure 10 shows the case where the additional NOP is needed.



NOTE: A CAS latency of three is used for illustration. The READ command may be to any bank, and the WRITE command may be to any bank. If a burst of one is used, then DQM is not required.

Figure 9
READ to WRITE



NOTE: A CAS latency of three is used for illustration. The READ command may be to any bank, and the WRITE command may be to any bank.

DON'T CARE

Figure 10
READ to WRITE with Extra Clock Cycle

A fixed-length READ burst may be followed by, or truncated with, a PRECHARGE command to the same bank (provided that AUTO PRECHARGE was not activated) and a full-page burst may be truncated with a PRECHARGE command to the same bank. The PRECHARGE command should be issued *x* cycles before the clock edge at which the last desired data element is valid, where *x* equals the CAS latency minus one. This is shown in Figure 11 for each possible CAS latency; data element *n* + 3 is either the last of a burst of four or the last desired of a longer burst. Following the PRECHARGE command, a subsequent command to the same bank cannot be issued until ^{t}RP is met. Note that part of the row precharge time is hidden during the access of the last data element(s).

In the case of a fixed-length burst being executed to completion, a PRECHARGE command issued at the optimum time (as described above) provides the same operation that would result from the same fixed-length burst with AUTO PRECHARGE. The disadvan-

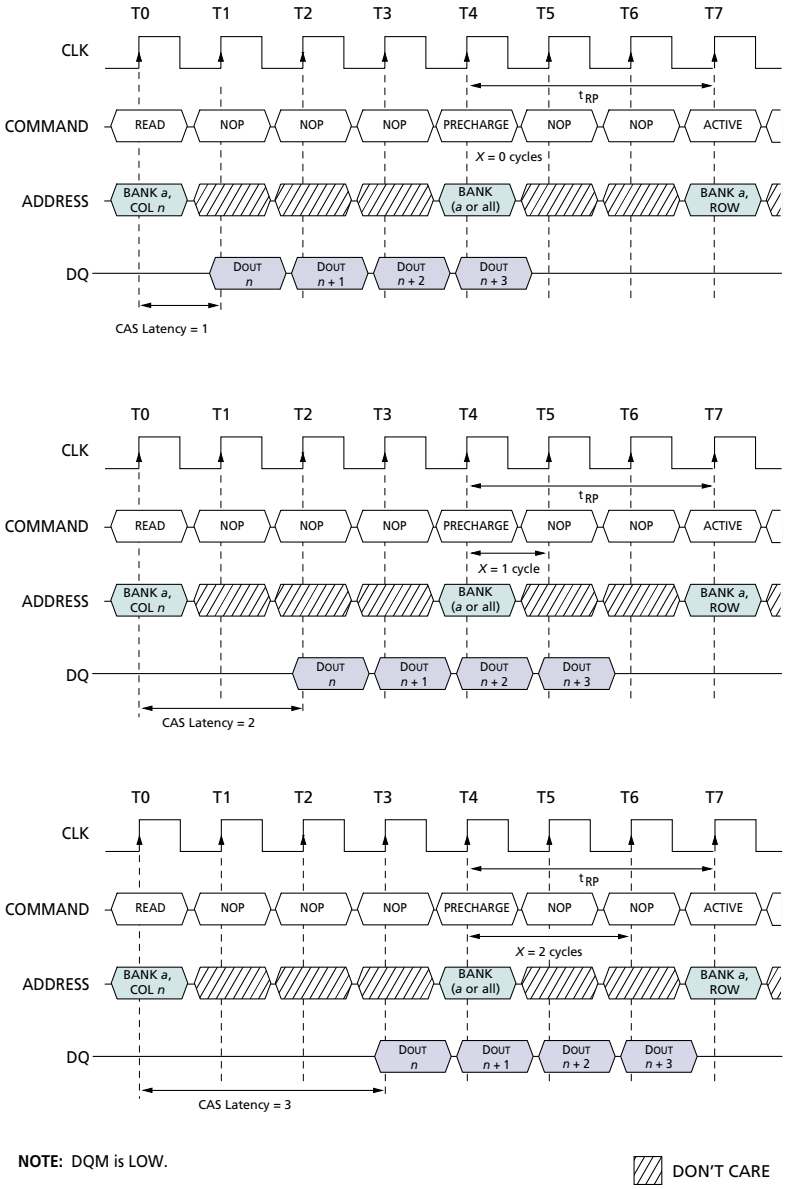


Figure 11
READ to PRECHARGE

tage of the PRECHARGE command is that it requires that the command and address buses be available at the appropriate time to issue the command; the advantage of the PRECHARGE command is that it can be used to truncate fixed-length or full-page bursts.

Full-page READ bursts can be truncated with the BURST TERMINATE command, and fixed-length READ bursts may be truncated with a BURST TERMINATE command, provided that AUTO PRECHARGE was not activated. The BURST TERMINATE command should be issued *x* cycles before the clock edge at which the last desired data element is valid, where *x* equals the CAS latency minus one. This is shown in Figure 12 for each possible CAS latency; data element *n* + 3 is the last desired data element of a longer burst.

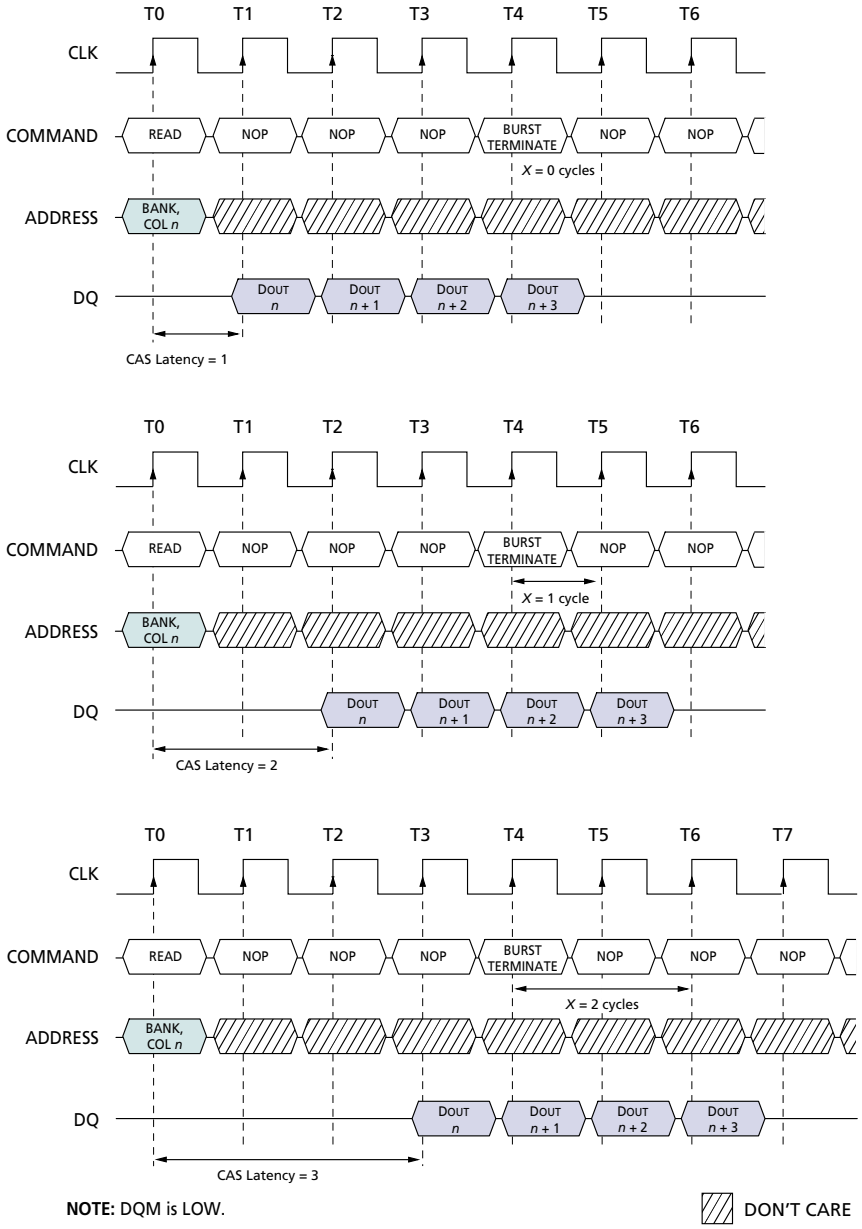


Figure 12
Terminating a READ Burst

WRITEs

WRITE bursts are initiated with a WRITE command, as shown in Figure 13.

The starting column and bank addresses are provided with the WRITE command and AUTO PRECHARGE is either enabled or disabled for that access. If AUTO PRECHARGE is enabled, the row being accessed is precharged at the completion of the burst. For the generic WRITE commands used in the following illustrations, AUTO PRECHARGE is disabled.

During WRITE bursts, the first valid data-in element will be registered coincident with the WRITE command. Subsequent data elements will be registered on each successive positive clock edge. Upon completion of a fixed-length burst, assuming no other commands have been initiated, the DQs will remain High-Z, and any additional input data will be ignored (see Figure 14). A full-page burst will continue until terminated. (At the end of the page it will wrap to column 0 and continue.)

Data for any WRITE burst may be truncated with a subsequent WRITE command, and data for a fixed-length WRITE burst may be immediately followed by data for a subsequent WRITE command. The new WRITE command can be issued on any clock following the previous WRITE command, and the data provided coincident with the new command applies to the new command. An example is shown in Figure 15. Data *n* + 1 is either the last of a burst of two, or the last desired of a longer burst. The 1 Meg x 16 SDRAM uses a pipelined architecture and therefore does not require the 2*n* rule associated with a prefetch architecture. A WRITE command can be initiated on any clock cycle following a previous WRITE command. Full-speed,

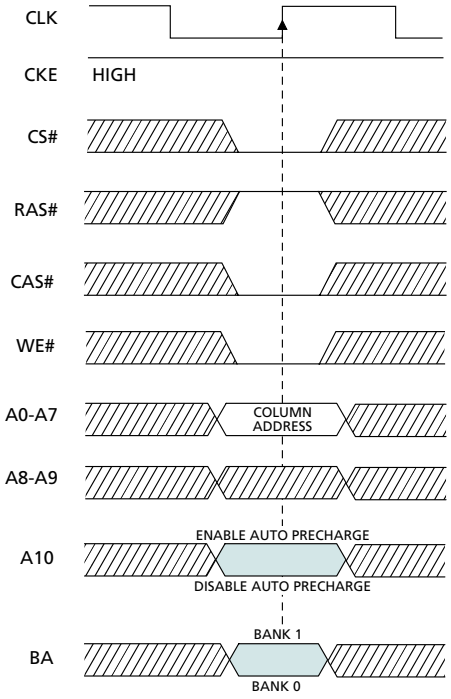
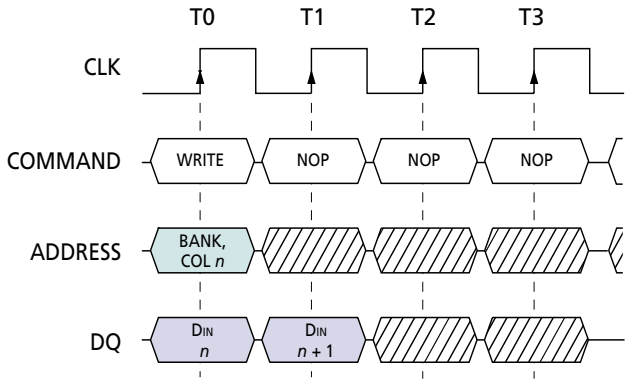
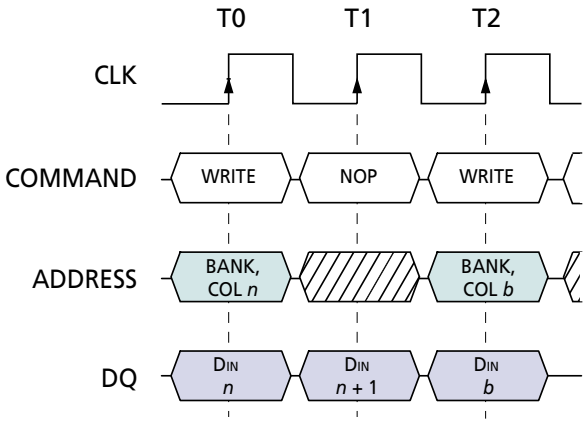


Figure 13
WRITE Command



NOTE: Burst length = 2. DQM is LOW.

Figure 14
WRITE Burst



NOTE: DQM is LOW. Each WRITE command may be to any bank.

DON'T CARE

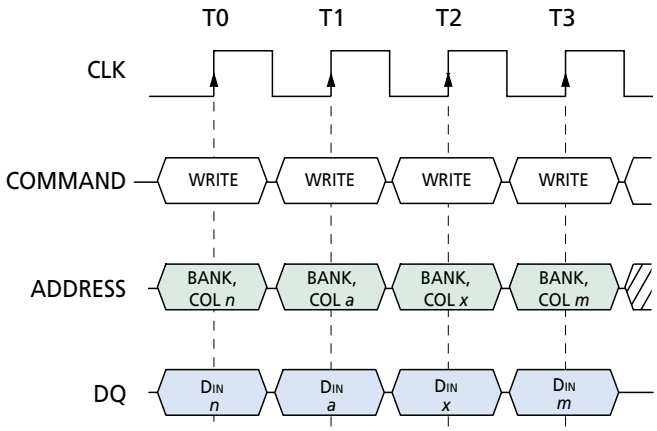
Figure 15
WRITE to WRITE

random write accesses within a page can be performed as shown in Figure 16.

Data for any WRITE burst may be truncated with a subsequent READ command, and data for a fixed-length WRITE burst may be immediately followed by a subsequent READ command. Once the READ command is registered, the data inputs will be ignored, and WRITEs will not be executed. An example is shown in Figure 17. Data $n + 1$ is either the last of a burst of two, or the last desired of a longer burst.

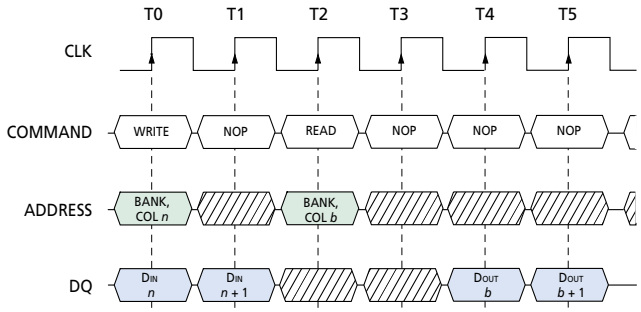
Data for a fixed-length WRITE burst may be followed by, or truncated with, a PRECHARGE command to the same bank (provided that AUTO PRECHARGE was not activated), and a full-page WRITE burst may be truncated with a PRECHARGE command to the same bank. The PRECHARGE command should be issued ^{t}WR after the clock edge at which the last desired input data element is registered. In addition, when truncating a WRITE burst, the DQM signal must be used to mask input data for the clock edge prior to, and the clock edge coincident with, the PRECHARGE command. An example is shown in Figure 18. Data $n + 1$ is either the last of a burst of two or the last desired of a longer burst. Following the PRECHARGE command, a subsequent command to the same bank cannot be issued until ^{t}RP is met.

In the case of a fixed-length burst being executed to completion, a PRECHARGE command issued at the optimum time (as described above) provides the same operation that would result from the same fixed-length burst with AUTO PRECHARGE. The disadvantage of the PRECHARGE command is that it requires that the command and address buses be available at the appropriate time to issue the command; the advantage of the PRECHARGE command is that it can be used to truncate fixed-length or full-page bursts.



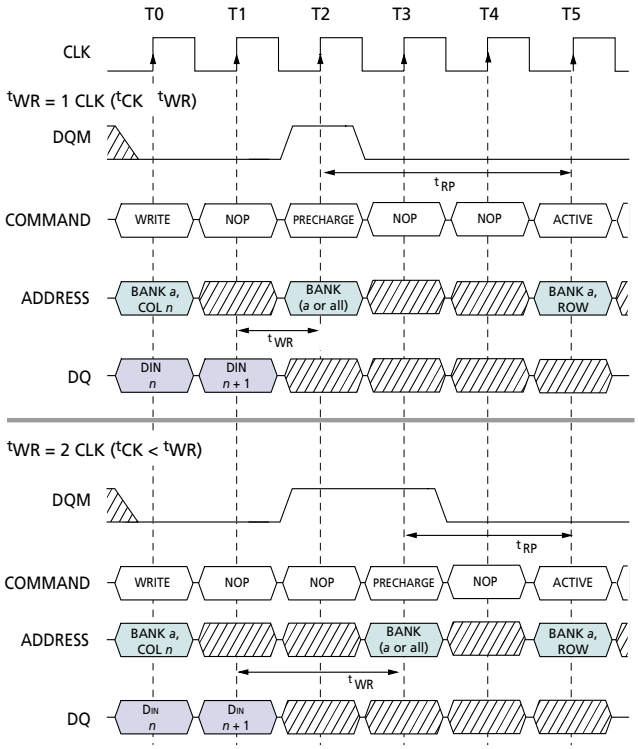
NOTE: Each WRITE command may be to any bank. DQM is LOW.

Figure 16
Random WRITE Cycles



NOTE: The WRITE command may be to any bank, and the READ command may be to any bank. DQM is LOW. CAS latency = 2 for illustration.

Figure 17
WRITE to READ

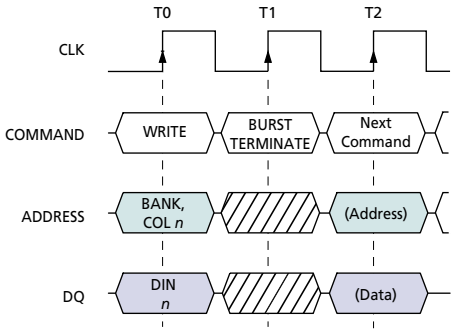


NOTE: DQM could remain LOW in this example if the WRITE burst is a fixed length of two. Future SDRAMs will require a ^{t}WR of at least two clocks.

DON'T CARE

Figure 18
WRITE to PRECHARGE

Fixed-length or full-page WRITE bursts can be truncated with the BURST TERMINATE command. When truncating a WRITE burst, the input data applied coincident with the BURST TERMINATE command will be ignored. The last data written (provided that DQM is LOW at that time) will be the input data applied one clock previous to the BURST TERMINATE command. This is shown in Figure 19, where data *n* is the last desired data element of a longer burst.



NOTE: DQMs are low

Figure 19
Terminating a WRITE Burst

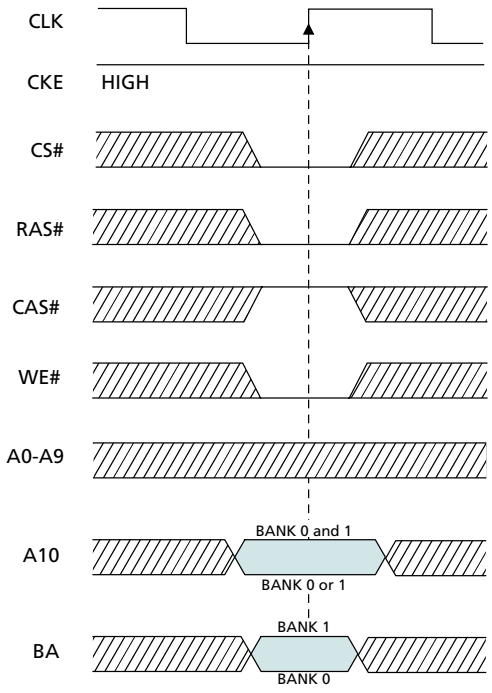


Figure 20
PRECHARGE Command

PRECHARGE

The PRECHARGE command is used to deactivate the open row in a particular bank or the open row in all banks (see Figure 20). The bank(s) will be available for a subsequent row access some specified time (^{t}RP) after the PRECHARGE command is issued. Input A10 determines whether one or all banks are to be precharged, and in the case where only one bank is to be precharged, input BA selects the bank. When all banks are to be precharged, input BA is treated as "Don't Care." Once a bank has been precharged, it is in the idle state and must be activated prior to any READ or WRITE commands being issued to that bank.

POWER-DOWN

POWER-DOWN occurs if CKE is registered LOW coincident with a NOP or COMMAND INHIBIT, when no accesses are in progress (see Figure 21). If POWER-DOWN occurs when all banks are idle, this mode is referred to as precharge power-down; if power-down occurs when there is a row active in either bank, this mode is referred to as active power-down. Entering power-down deactivates the input and output buffers, excluding CKE, for maximum power savings while in standby. The device may not remain in the power-down state longer than the refresh period (64ms) since no refresh operations are performed in this mode.

The power-down state is exited by registering a NOP or COMMAND INHIBIT and CKE HIGH at the desired clock edge (meeting ^{t}CKS).

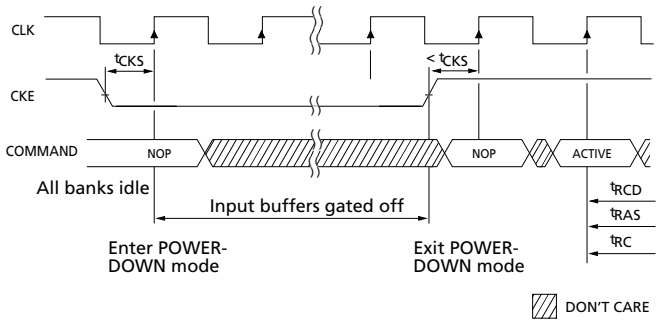


Figure 21
POWER-DOWN

CLOCK SUSPEND

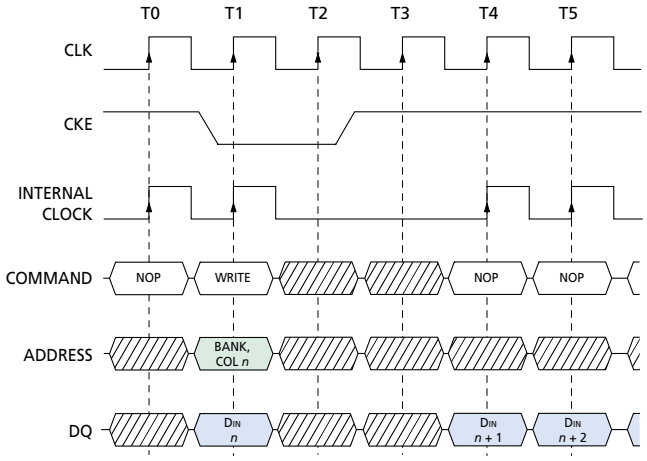
The clock suspend mode occurs when a column access/burst is in progress and CKE is registered LOW. In the clock suspend mode, the internal clock is deactivated, "freezing" the synchronous logic.

For each positive clock edge on which CKE is sampled LOW, the next internal positive clock edge is suspended. Any command or data present on the input pins at the time of a suspended internal clock edge are ignored; any data present on the DQ pins will remain driven; and burst counters are not incremented as long as the clock is suspended (see examples in Figures 22 and 23).

Clock suspend mode is exited by registering CKE HIGH; the internal clock and related operation will resume on the subsequent positive clock edge.

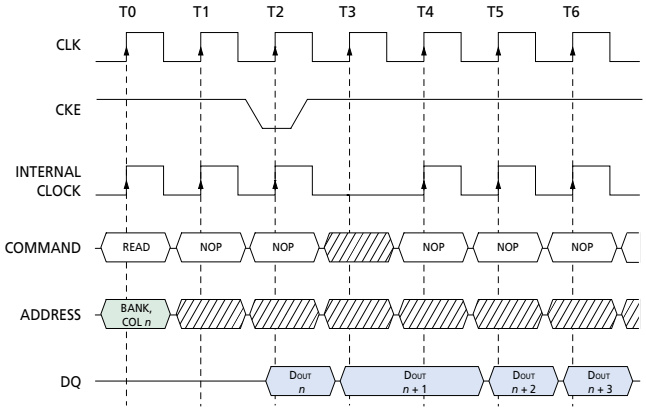
BURST READ/SINGLE WRITE

The burst read/single write mode is entered by programming the write burst mode bit (M9) in the Mode Register to a logic 1. In this mode, all WRITE commands result in the access of a single column location (burst of one) regardless of the programmed burst length. READ commands access columns according to the programmed burst length and sequence, just as in the normal mode of operation (M9 = 0).



NOTE: For this example, burst length = 4 or greater, and DQM is LOW.

Figure 22
Clock Suspend During WRITE Burst



NOTE: For this example, CAS latency = 2, burst length = 4 or greater, and DQM is LOW.

DON'T CARE

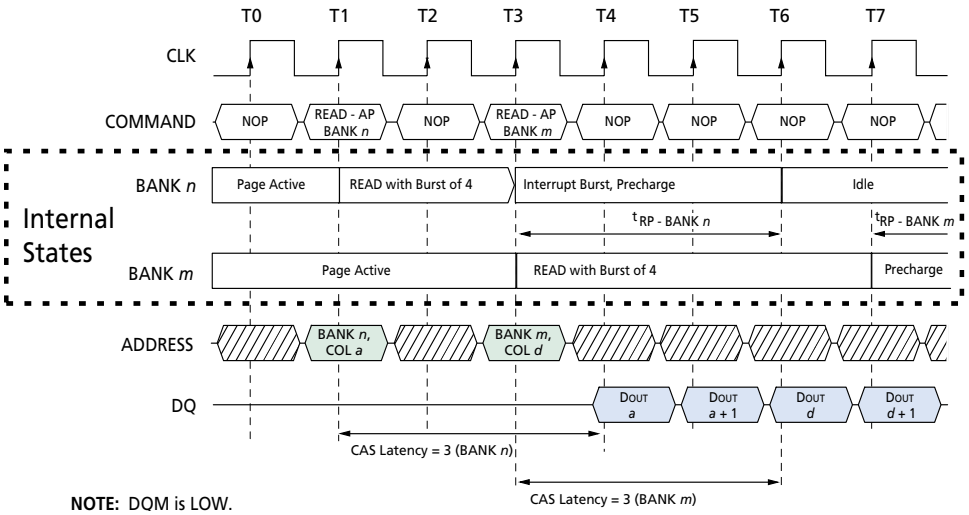
Figure 23
Clock Suspend During READ Burst

CONCURRENT AUTO PRECHARGE

An access command (READ or WRITE) to another bank while an access command with AUTO PRECHARGE enabled is executing is not allowed by SDRAMs, unless the SDRAM supports CONCURRENT AUTO PRECHARGE. Micron SDRAMs support CONCURRENT AUTO PRECHARGE. Four cases where CONCURRENT AUTO PRECHARGE occurs are defined below.

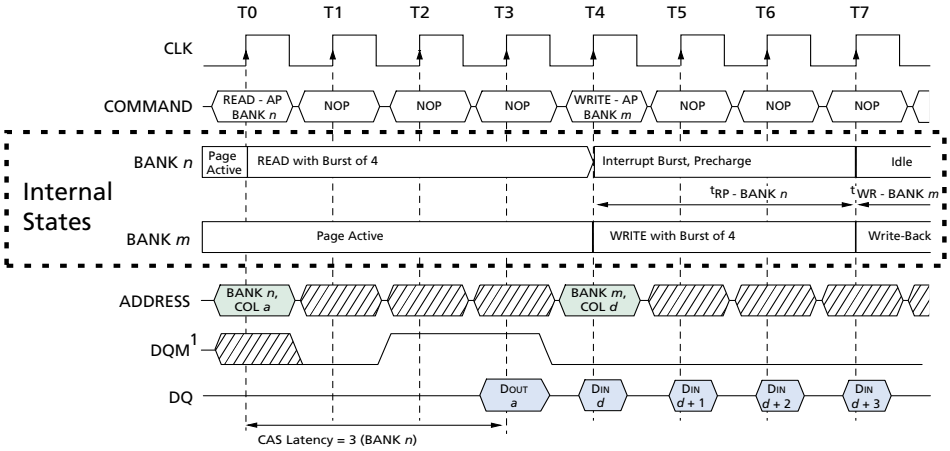
READ with AUTO PRECHARGE

1. Interrupted by a READ (with or without AUTO PRECHARGE): A READ to bank m will interrupt a READ on bank n, CAS latency later. The PRECHARGE to bank n will begin when the READ to bank m is registered (Figure 24).
2. Interrupted by a WRITE (with or without AUTO PRECHARGE): A WRITE to bank m will interrupt a READ on bank n when registered. DQM should be used two clocks prior to the WRITE command to prevent bus contention. The PRECHARGE to bank n will begin when the WRITE to bank m is registered (Figure 25).



NOTE: DQM is LOW.

Figure 24
READ with AUTO PRECHARGE Interrupted by a READ

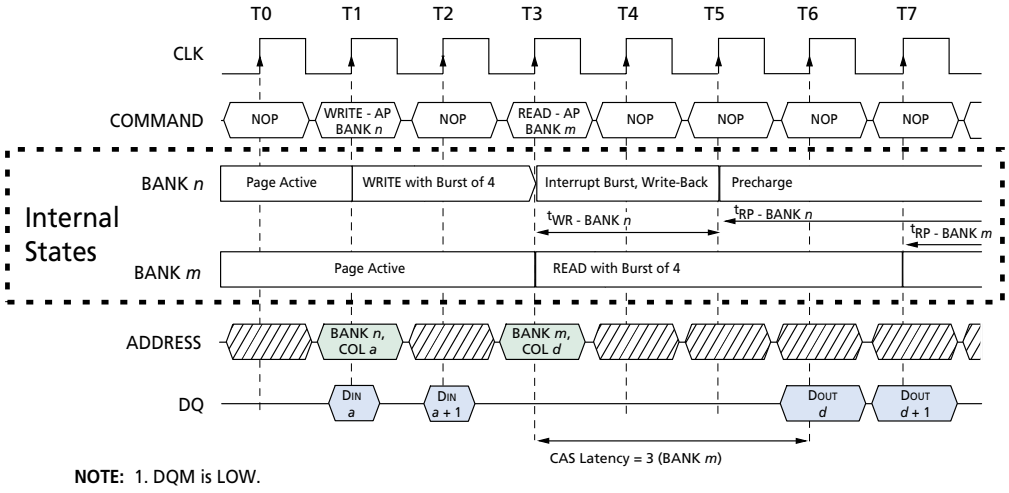


NOTE: 1. DQM is HIGH at T2 to prevent DOUT-*a*+1 from contending with DIN-*d* at T4.

Figure 25
READ with AUTO PRECHARGE Interrupted by a WRITE

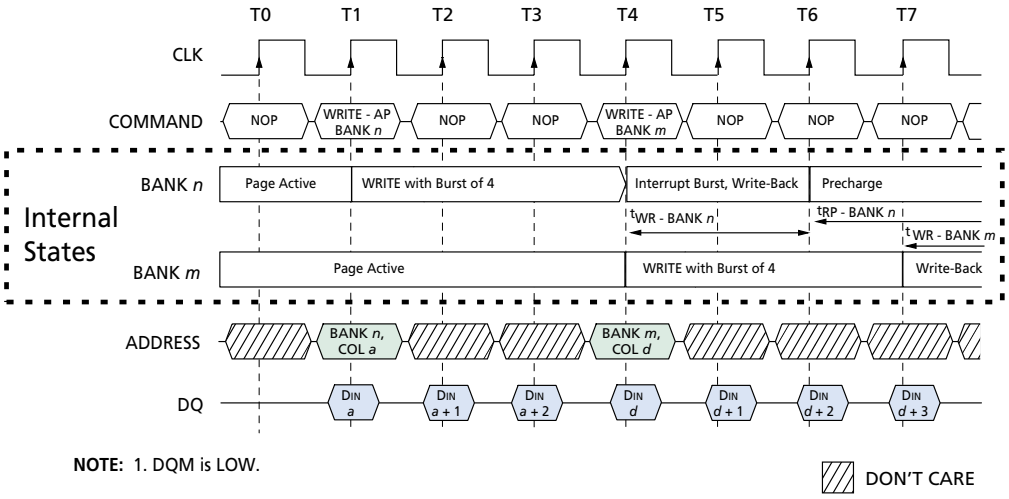
WRITE with AUTO PRECHARGE

3. Interrupted by a READ (with or without AUTO PRECHARGE): A READ to bank m will interrupt a WRITE on bank n when registered, with the data-out appearing CAS latency later. The PRECHARGE to bank n will begin after ^{t}WR is met, where ^{t}WR begins when the READ to bank m is registered. The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m (Figure 26).
4. Interrupted by a WRITE (with or without AUTO PRECHARGE): A WRITE to bank m will interrupt a WRITE on bank n when registered. The PRECHARGE to bank n will begin after ^{t}WR is met, where ^{t}WR begins when the WRITE to bank m is registered. The last valid data WRITE to bank n will be data registered one clock prior to a WRITE to bank m (Figure 27).



NOTE: 1. DQM is LOW.

Figure 26
WRITE with AUTO PRECHARGE Interrupted by a READ



NOTE: 1. DQM is LOW.

Figure 27
WRITE with AUTO PRECHARGE Interrupted by a WRITE

TRUTH TABLE 2 – CKE

(Notes: 1-4)

CKE_{n-1}	CKE_n	CURRENT STATE	$COMMAND_n$	$ACTION_n$	NOTES
L	L	Power-Down	X	Maintain Power-Down	
		Self Refresh	X	Maintain Self Refresh	
		Clock Suspend	X	Maintain Clock Suspend	
L	H	Power-Down	COMMAND INHIBIT or NOP	Exit Power-Down	5
		Self Refresh	COMMAND INHIBIT or NOP	Exit Self Refresh	6
		Clock Suspend	X	Exit Clock Suspend	7
H	L	All Banks Idle	COMMAND INHIBIT or NOP	Power-Down Entry	
		All Banks Idle	AUTO REFRESH	Self Refresh Entry	
		Reading or Writing	VALID	Clock Suspend Entry	
H	H		See Truth Table 3		

NOTE:
1. CKE_n is the logic state of CKE at clock edge *n*; CKE_{n-1} was the state of CKE at the previous clock edge.
2. Current state is the state of the SDRAM immediately prior to clock edge *n*.
3. $COMMAND_n$ is the command registered at clock edge *n* and $ACTION_n$ is a result of $COMMAND_n$.
4. All states and sequences not shown are illegal or reserved.
5. Exiting power-down at clock edge *n* will put the device in the all banks idle state in time for clock edge *n + 1* (provided that ^tCKS is met).
6. Exiting SELF REFRESH at clock edge *n* will put the device in the all banks idle state once ^tXSR is met. COMMAND INHIBIT or NOP commands should be issued on any clock edges occurring during the ^tXSR period. A minimum of two NOP commands must be provided during ^tXSR period.
7. After exiting clock suspend at clock edge *n*, the device will resume operation and recognize the next command at clock edge *n + 1*.

TRUTH TABLE 3 – CURRENT STATE BANK *n* - COMMAND TO BANK *n*

(Notes: 1-6; notes appear below and on next page)

CURRENT STATE	CS#	RAS#	CAS#	WE#	COMMAND (ACTION)	NOTES
Any	H	X	X	X	COMMAND INHIBIT (NOP/Continue previous operation)	
	L	H	H	H	NO OPERATION (NOP/Continue previous operation)	
Idle	L	L	H	H	ACTIVE (Select and activate row)	
	L	L	L	H	AUTO REFRESH	7
	L	L	L	L	LOAD MODE REGISTER	7
	L	L	H	L	PRECHARGE	11
Row Active	L	H	L	H	READ (Select column and start READ burst)	10
	L	H	L	L	WRITE (Select column and start WRITE burst)	10
	L	L	H	L	PRECHARGE (Deactivate row in bank or banks)	8
Read (Auto Precharge Disabled)	L	H	L	H	READ (Select column and start new READ burst)	10
	L	H	L	L	WRITE (Select column and start WRITE burst)	10
	L	L	H	L	PRECHARGE (Truncate READ burst, start PRECHARGE)	8
	L	H	H	L	BURST TERMINATE	9
Write (Auto Precharge Disabled)	L	H	L	H	READ (Select column and start READ burst)	10
	L	H	L	L	WRITE (Select column and start new WRITE burst)	10
	L	L	H	L	PRECHARGE (Truncate WRITE burst, start PRECHARGE)	8
	L	H	H	L	BURST TERMINATE	9

NOTE:

1. This table applies when CKE_{n-1} was HIGH and CKE_n is HIGH (see Truth Table 2) and after ^tXSR has been met (if the previous state was self refresh).
2. This table is bank-specific, except where noted; i.e., the current state is for a specific bank and the commands shown are those allowed to be issued to that bank when in that state. Exceptions are covered in the notes below.
3. Current state definitions:
   - Idle: The bank has been precharged and ^tRP has been met.
   - Row Active: A row in the bank has been activated and ^tRCD has been met. No data bursts/accesses and no register accesses are in progress.
   - Read: A READ burst has been initiated, with AUTO PRECHARGE disabled, and has not yet terminated or been terminated.
   - Write: A WRITE burst has been initiated, with AUTO PRECHARGE disabled, and has not yet terminated or been terminated.
4. The following states must not be interrupted by a command issued to the same bank. COMMAND INHIBIT or NOP commands, or allowable commands to the other bank, should be issued on any clock edge occuring during these states. Allowable commands to the other bank are determined by its current state and Truth Table 3, and according to Truth Table 4.
   - Precharging: Starts with registration of a PRECHARGE command and ends when ^tRP is met. Once ^tRP is met, the bank will be in the idle state.
   - Row Activating: Starts with registration of an ACTIVE command and ends when ^tRCD is met. Once ^tRCD is met, the bank will be in the row active state.
   - Read w/Auto Precharge Enabled: Starts with registration of a READ command with AUTO PRECHARGE enabled and ends when ^tRP has been met. Once ^tRP is met, the bank will be in the idle state.
   - Write w/Auto Precharge Enabled: Starts with registration of a WRITE command with AUTO PRECHARGE enabled and ends when ^tRP has been met. Once ^tRP is met, the bank will be in the idle state.

NOTE (continued):

5. The following states must not be interrupted by any executable command; COMMAND INHIBIT or NOP commands must be applied on each positive clock edge during these states.
   - Refreshing: Starts with registration of an AUTO REFRESH command and ends when ^{t}RC is met. Once ^{t}RC is met, the SDRAM will be in the all banks idle state.
   - Accessing Mode Register: Starts with registration of a LOAD MODE REGISTER command and ends when ^{t}MRD has been met. Once ^{t}MRD is met, the SDRAM will be in the all banks idle state.
   - Precharging All: Starts with registration of a PRECHARGE ALL command and ends when ^{t}RP is met. Once ^{t}RP is met, all banks will be in the idle state.
6. All states and sequences not shown are illegal or reserved.
7. Not bank-specific; requires that all banks are idle.
8. May or may not be bank-specific; if all banks are to be precharged, all must be in a valid state for precharging.
9. Not bank-specific; BURST TERMINATE affects the most recent READ or WRITE burst, regardless of bank.
10. READs or WRITEs listed in the Command (Action) column include READs or WRITEs with AUTO PRECHARGE enabled and READs or WRITEs with AUTO PRECHARGE disabled.
11. Does not affect the state of the bank and acts as a NOP to that bank.

TRUTH TABLE 4 – CURRENT STATE BANK *n* - COMMAND TO BANK *m*

(Notes: 1-6; notes appear below and on next page)

CURRENT STATE	CS#	RAS#	CAS#	WE#	COMMAND (ACTION)	NOTES
Any	H	X	X	X	COMMAND INHIBIT (NOP/Continue previous operation)	
	L	H	H	H	NO OPERATION (NOP/Continue previous operation)	
Idle	X	X	X	X	Any command otherwise allowed to bank m	
Row Activating,	L	L	H	H	ACTIVE (Select and activate row)	
Active or	L	H	L	H	READ (Select column and start READ burst)	7
Precharging	L	H	L	L	WRITE (Select column and start WRITE burst)	7
	L	L	H	L	PRECHARGE	
Read	L	L	H	H	ACTIVE (Select and activate row)	
(Auto	L	H	L	H	READ (Select column and start new READ burst)	7, 10
Precharge	L	H	L	L	WRITE (Select column and start WRITE burst)	7, 11
Disabled)	L	L	H	L	PRECHARGE	9
Write	L	L	H	H	ACTIVE (Select and activate row)	
(Auto	L	H	L	H	READ (Select column and start READ burst)	7, 12
Precharge	L	H	L	L	WRITE (Select column and start new WRITE burst)	7, 13
Disabled)	L	L	H	L	PRECHARGE	9
Read	L	L	H	H	ACTIVE (Select and activate row)	
(With Auto	L	H	L	H	READ (Select column and start new READ burst)	7, 8, 14
Precharge)	L	H	L	L	WRITE (Select column and start WRITE burst)	7, 8, 15
	L	L	H	L	PRECHARGE	9
Write	L	L	H	H	ACTIVE (Select and activate row)	
(With Auto	L	H	L	H	READ (Select column and start READ burst)	7, 8, 16
Precharge)	L	H	L	L	WRITE (Select column and start new WRITE burst)	7, 8, 17
	L	L	H	L	PRECHARGE	9

NOTE:
1. This table applies when CKE_{n-1} was HIGH and CKE_n is HIGH (see Truth Table 2) and after ^tXSR has been met (if the previous state was self refresh).
2. This table describes alternate bank operation, except where noted, i.e., the current state is for bank *n* and the commands shown are those allowed to be issued to bank m (assuming that bank m is in such a state that the given command is allowable). Exceptions are covered in the notes below.
3. Current state definitions:

Idle:	The bank has been precharged and ^tRP has been met.
Row Active:	A row in the bank has been activated and ^tRCD has been met. No data bursts/accesses and no register accesses are in progress.
Read:	A READ burst has been initiated, with AUTO PRECHARGE disabled, and has not yet terminated or been terminated.
Write:	A WRITE burst has been initiated, with AUTO PRECHARGE disabled, and has not yet terminated or been terminated.
Read w/Auto Precharge Enabled:	Starts with registration of a READ command with AUTO PRECHARGE enabled and ends when ^tRP has been met. Once ^tRP is met, the bank will be in the idle state.
Write w/Auto Precharge Enabled:	Starts with registration of a WRITE command with AUTO PRECHARGE enabled and ends when ^tRP has been met. Once ^tRP is met, the bank will be in the idle state.

NOTE (continued):

4. AUTO REFRESH, SELF REFRESH and LOAD MODE REGISTER commands may only be issued when all banks are idle.
5. A BURST TERMINATE command cannot be issued to another bank; it applies to the bank represented by the current state only.
6. All states and sequences not shown are illegal or reserved.
7. READs or WRITEs to bank m listed in the Command (Action) column include READs or WRITEs with AUTO PRECHARGE enabled and READs or WRITEs with AUTO PRECHARGE disabled.
8. CONCURRENT AUTO PRECHARGE: Bank n will initiate the AUTO PRECHARGE command when its burst has been interrupted by bank m's burst.
9. Burst in bank n continues as initiated.
10. For a READ without AUTO PRECHARGE interrupted by a READ (with or without AUTO PRECHARGE), the READ to bank m will interrupt the READ on bank n, CAS latency later (Figure 7).
11. For a READ without AUTO PRECHARGE interrupted by a WRITE (with or without AUTO PRECHARGE), the WRITE to bank m will interrupt the READ on bank n when registered (Figures 9 and 10). DQM should be used one clock prior to the WRITE command to prevent bus contention.
12. For a WRITE without AUTO PRECHARGE interrupted by a READ (with or without AUTO PRECHARGE), the READ to bank m will interrupt the WRITE on bank n when registered (Figure 17), with the data-out appearing CAS latency later. The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m.
13. For a WRITE without AUTO PRECHARGE interrupted by a WRITE (with or without AUTO PRECHARGE), the WRITE to bank m will interrupt the WRITE on bank n when registered (Figure 15). The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m.
14. For a READ with AUTO PRECHARGE interrupted by a READ (with or without AUTO PRECHARGE), the READ to bank m will interrupt the READ on bank n, CAS latency later. The PRECHARGE to bank n will begin when the READ to bank m is registered (Figure 24).
15. For a READ with AUTO PRECHARGE interrupted by a WRITE (with or without AUTO PRECHARGE), the WRITE to bank m will interrupt the READ on bank n when registered. DQM should be used two clocks prior to the WRITE command to prevent bus contention. The PRECHARGE to bank n will begin when the WRITE to bank m is registered (Figure 25).
16. For a WRITE with AUTO PRECHARGE interrupted by a READ (with or without AUTO PRECHARGE), the READ to bank m will interrupt the WRITE on bank n when registered, with the data-out appearing CAS latency later. The PRECHARGE to bank n will begin after ^{t}WR is met, where ^{t}WR begins when the READ to bank m is registered. The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m (Figure 26).
17. For a WRITE with AUTO PRECHARGE interrupted by a WRITE (with or without AUTO PRECHARGE), the WRITE to bank m will interrupt the WRITE on bank n when registered. The PRECHARGE to bank n will begin after ^{t}WR is met, where ^{t}WR begins when the WRITE to bank m is registered. The last valid WRITE to bank n will be data registered one clock prior to the WRITE to bank m (Figure 27).

ABSOLUTE MAXIMUM RATINGS*

Voltage on V_{DD}, $V_{DD}Q$ Supply
Relative to V_{SS} ..... -1V to +4.6V
Voltage on Inputs, NC or I/O Pins
Relative to V_{SS} ..... -1V to +4.6V
Operating Temperature, T_A (ambient) .. 0°C to +70°C
Storage Temperature (plastic) ..... -55°C to +150°C
Power Dissipation 1W

*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC ELECTRICAL CHARACTERISTICS AND OPERATING CONDITIONS

(Notes: 1, 6) (0°C ≤ T_A ≤ 70°C; V_{DD}, $V_{DD}Q$ = +3.3V ±0.3V)

PARAMETER/CONDITION	SYMBOL	MIN	MAX	UNITS	NOTES
SUPPLY VOLTAGE	V_{DD}, $V_{DD}Q$	3	3.6	V	
INPUT HIGH VOLTAGE: Logic 1; All inputs	V_{IH}	2	V_{DD} + 0.3	V	22
INPUT LOW VOLTAGE: Logic 0; All inputs	V_{IL}	-0.3	0.8	V	22
INPUT LEAKAGE CURRENT: Any input 0V ≤ V_{IN} ≤ V_{DD} (All other pins not under test = 0V)	I_I	-5	5	µA	
OUTPUT LEAKAGE CURRENT: DQs are disabled; 0V ≤ V_{OUT} ≤ $V_{DD}Q$	I_{OZ}	-10	10	µA	
OUTPUT LEVELS: Output High Voltage (I_{OUT} = -4mA)	V_{OH}	2.4	–	V	
Output Low Voltage (I_{OUT} = 4mA)	V_{OL}	–	0.4	V	

I_{DD} SPECIFICATIONS AND CONDITIONS

(Notes: 1, 6, 11, 13) (0°C ≤ T_A ≤ 70°C; V_{DD}, $V_{DD}Q$ = +3.3V ±0.3V)

		MAX				
PARAMETER/CONDITION	SYMBOL	-6	-7	-8A	UNITS	NOTES
OPERATING CURRENT: Active Mode; Burst = 2; READ or WRITE; ^tRC = ^tRC (MIN); CAS latency = 3	I_{DD1}	145	140	135	mA	3, 18, 19, 26
STANDBY CURRENT: Power-Down Mode; CKE = LOW; All banks idle	I_{DD2}	2	2	2	mA	26
STANDBY CURRENT: Active Mode; CS# = HIGH; CKE = HIGH; All banks active after ^tRCD met; No accesses in progress	I_{DD3}	45	40	35	mA	3, 12, 19, 26
OPERATING CURRENT: Burst Mode; Continuous burst; READ or WRITE; All banks active, CAS latency = 3	I_{DD4}	140	130	100	mA	3, 18, 19, 26
AUTO REFRESH CURRENT: ^tRC = 15.625µs; CAS latency = 3; CS# = HIGH; CKE = HIGH	I_{DD5}	45	40	35	mA	3, 12, 18, 19, 26
SELF REFRESH CURRENT: CKE ≤ 0.2V	I_{DD6}	1	1	1	mA	4

CAPACITANCE

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
Input Capacitance: CLK	C_{I1}	2.5	4.0	pF	2
Input Capacitance: All other input-only pins	C_{I2}	2.5	5.0	pF	2
Input/Output Capacitance: DQs	C_{IO}	4.0	6.5	pF	2

ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS

(Notes: 5, 6, 8, 9, 11) (0°C ≤ T_A ≤ +70°C)

AC CHARACTERISTICS			-6		-7		-8A			
PARAMETER		SYMBOL	MIN	MAX	MIN	MAX	MIN	MAX	UNITS	NOTES
Access time from CLK (pos. edge)	CL = 3	^tAC		5.5		5.5		6	ns	
	CL = 2	^tAC		8		8.5		9	ns	22
	CL = 1	^tAC		18		22		22	ns	22
Address hold time		^tAH	1		1		1		ns	
Address setup time		^tAS	2		2		2		ns	
CLK high level width		^tCH	2.5		2.75		3		ns	
CLK low level width		^tCL	2.5		2.75		3		ns	
Clock cycle time	CL = 3	^tCK	6		7		8		ns	23
	CL = 2	^tCK	8		10		13		ns	22, 23
	CL = 1	^tCK	20		25		25		ns	23
CKE hold time		^tCKH	1		1		1		ns	
CKE setup time		^tCKS	2		2		2		ns	
CS#, RAS#, CAS#, WE#, DQM hold time		^tCMH	1		1		1		ns	
CS#, RAS#, CAS#, WE#, DQM setup time		^tCMS	2		2		2		ns	
Data-in hold time		^tDH	1		1		1		ns	
Data-in setup time		^tDS	2		2		2		ns	
Data-out high-impedance time	CL = 3	^tHZ		5.5		5.5		6	ns	10
	CL = 2	^tHZ		8		8.5		9	ns	10
	CL = 1	^tHZ		18		22		22	ns	10
Data-out low-impedance time		^tLZ	1		1		1		ns	
Data-out hold time		^tOH	2		2		2.5		ns	
ACTIVE to PRECHARGE command		^tRAS	42	120,000	42	120,000	48	120,000	ns	
AUTO REFRESH, ACTIVE command period		^tRC	60		70		80		ns	22
AUTO REFRESH period		^tRCAR	66		70		80		ns	
ACTIVE to READ or WRITE delay		^tRCD	18		20		24		ns	22
Refresh period - 2,048 or 4,096 rows		^tREF		64		64		64	ms	
PRECHARGE command period		^tRP	18		21		24		ns	22
ACTIVE bank A to ACTIVE bank B command		^tRRD	12		14		16		ns	
Transition time		^tT	0.3	1.2	0.3	1.2	0.3	10	ns	7
WRITE recovery time		^tWR	1 + 4ns		1 + 3ns		1 + 2ns		^tCK	24
			10		10		10		ns	25
Exit SELF REFRESH to ACTIVE command		^tXSR	80		80		80		ns	20

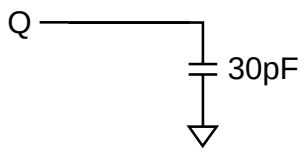
AC FUNCTIONAL CHARACTERISTICS

(Notes: 5, 6, 7, 8, 9, 11) (0°C ≤ T_A ≤ +70°C)

PARAMETER		SYMBOL	-6	-7	-8A	UNITS	NOTES
READ/WRITE command to READ/WRITE command		^tCCD	1	1	1	^tCK	17
CKE to clock disable or power-down entry mode		^tCKED	1	1	1	^tCK	14
CKE to clock enable or power-down exit setup mode		^tPED	1	1	1	^tCK	14
DQM to input data delay		^tDQD	0	0	0	^tCK	17
DQM to data mask during WRITEs		^tDQM	0	0	0	^tCK	17
DQM to data high-impedance during READs		^tDQZ	2	2	2	^tCK	17
WRITE command to input data delay		^tDWD	0	0	0	^tCK	17
Data-in to ACTIVE command	CL = 3	^tDAL	5	5	5	^tCK	15, 21
	CL = 2	^tDAL	4	4	4	^tCK	15, 21
	CL = 1	^tDAL	3	3	3	^tCK	15, 21
Data-in to PRECHARGE		^tDPL	2	2	2	^tCK	16
Last data-in to burst STOP command		^tBDL	0	0	0	^tCK	17
Last data-in to new READ/WRITE command		^tCDL	1	1	1	^tCK	17
Last data-in to PRECHARGE command		^tRDL	1	1	1	^tCK	16, 21
LOAD MODE REGISTER command to ACTIVE or REFRESH command		^tMRD	2	2	2	^tCK	26
Data-out to high-impedance from PRECHARGE command	CL = 3	^tROH	3	3	3	^tCK	17
	CL = 2	^tROH	2	2	2	^tCK	17
	CL = 1	^tROH	1	1	1	^tCK	17

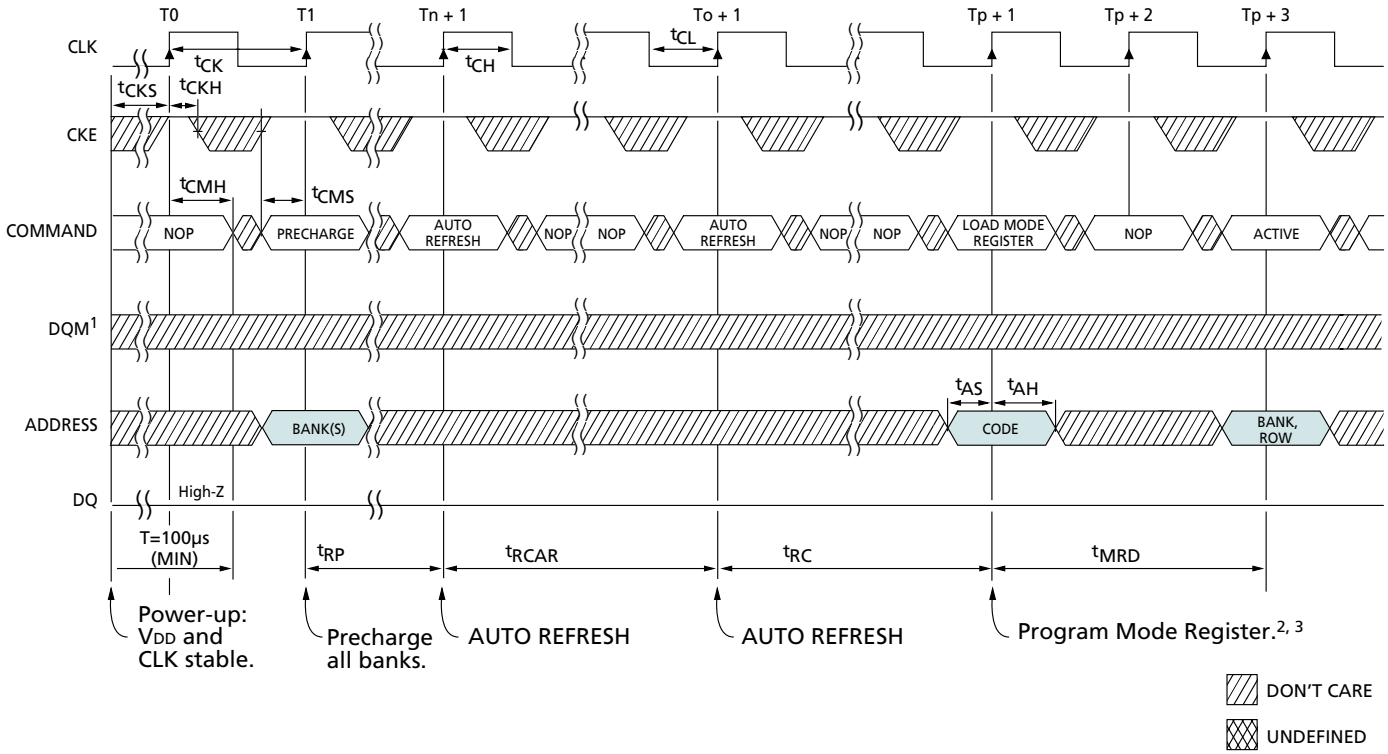
NOTES

1. All voltages referenced to V_{SS}.
2. This parameter is sampled. V_{DD}, $V_{DD}Q$ = +3.3V; f = 1 MHz, ^{t}A = 25°C.
3. I_{DD} is dependent on output loading and cycle rates. Specified values are obtained with minimum cycle time and the outputs open.
4. Enables on-chip refresh and address counters.
5. The minimum specifications are used only to indicate cycle time at which proper operation over the full temperature range (0°C ≤ T_A ≤ 70°C) is ensured.
6. An initial pause of 100µs is required after power-up, followed by two AUTO REFRESH commands, before proper device operation is ensured. (V_{DD} and $V_{DD}Q$ must be powered up simultaneously. V_{SS} and $V_{SS}Q$ must be at same potential.) The two AUTO REFRESH command wake-ups should be repeated any time the ^{t}REF refresh requirement is exceeded.
7. AC characteristics assume ^{t}T = 1ns.
8. In addition to meeting the transition rate specification, the clock and CKE must transit between V_{IH} and V_{IL} (or between V_{IL} and V_{IH}) in a monotonic manner.
9. Outputs measured at 1.4V with equivalent load:



10. ^{t}HZ defines the time at which the output achieves the open circuit condition; it is not a reference to V_{OH} or V_{OL}. The last valid data element will meet ^{t}OH before going High-Z.
11. AC timing and I_{DD} tests have V_{IL} = 0V and V_{IH} = 2.8V with timing referenced to 1.4V crossover point.
12. Other input signals are allowed to transition no more than once in any two-clock period and are otherwise at valid V_{IH} or V_{IL} levels.
13. I_{DD} specifications are tested after the device is properly initialized.
14. Timing actually specified by ^{t}CKS; clock(s) specified as a reference only at minimum cycle rate.
15. Timing actually specified by ^{t}WR plus ^{t}RP; clock(s) specified as a reference only at minimum cycle rate.
16. Timing actually specified by ^{t}WR.
17. Required clocks are specified by JEDEC functionality and are not dependent on any timing parameter.
18. The I_{DD} current will decrease as the CAS latency is reduced. This is due to the fact that the maximum cycle rate is slower as the CAS latency is reduced.
19. Address transitions average one transition every two-clock period.
20. CLK must be toggled a minimum of two times during this period.
21. Based on ^{t}CK = 166 MHz for -6, 143 MHz for -7 and 125 MHz for -8A.
22. V_{IH} overshoot: V_{IH} (MAX) = $V_{DD}Q$ + 2V for a pulse width ≤ 3ns, and the pulse width cannot be greater than one third of the cycle rate. V_{IL} undershoot: V_{IL} (MIN) = -2V for a pulse width ≤ 3ns. The pulse width cannot be greater than one third of the cycle rate.
23. The clock frequency must remain constant during access or precharge states (READ, WRITE, including ^{t}WR, and PRECHARGE commands). CKE may be used to reduce the data rate.
24. Auto precharge mode only.
25. Precharge mode only.
26. ^{t}CK = 6ns for -6, 7ns for -7, 8ns for -8A.

INITIALIZE AND LOAD MODE REGISTER



TIMING PARAMETERS

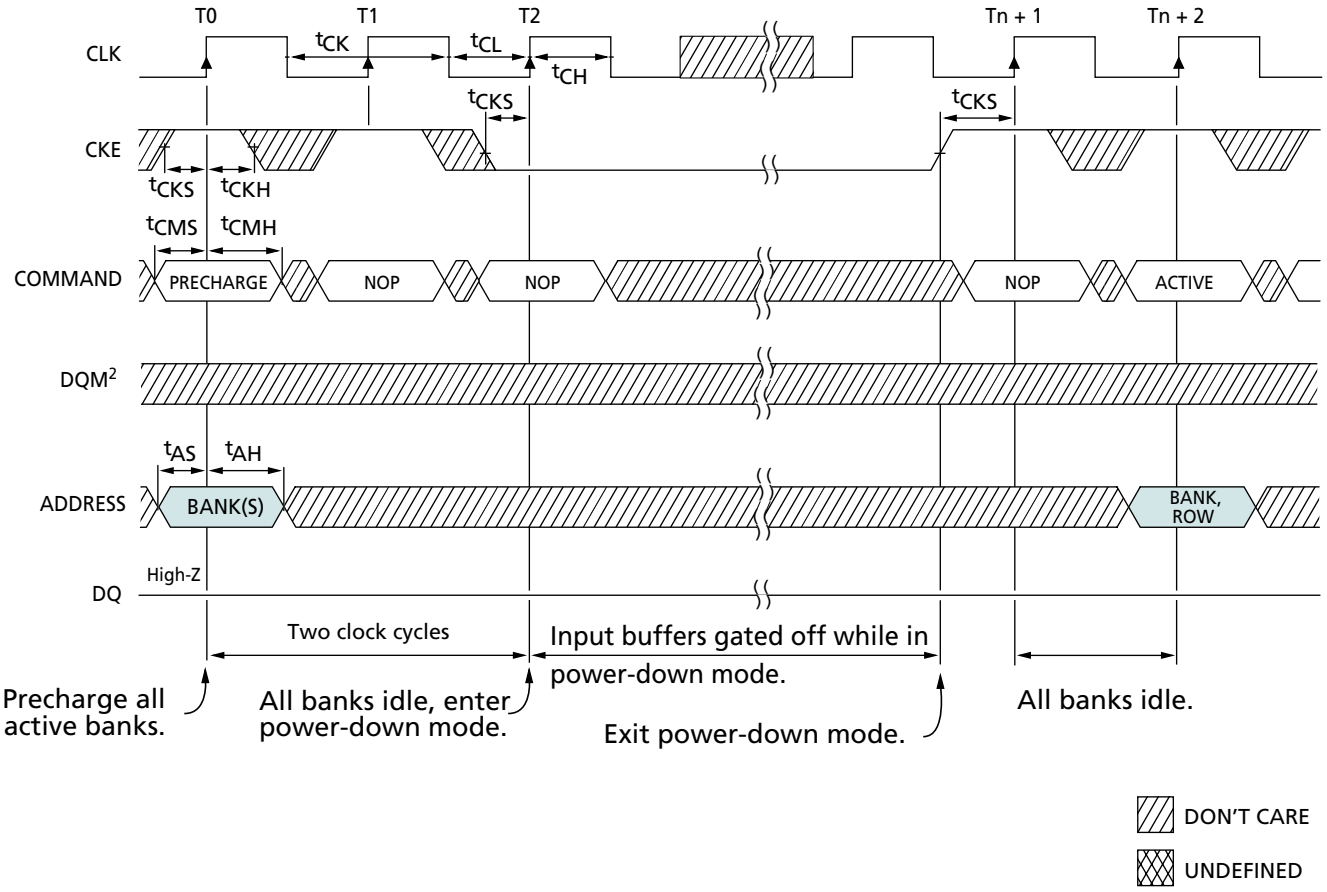
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tMRD	2		2		2		tCK
tRC	60		70		80		ns
tRCAR	66		70		80		ns
tRP	18		21		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.
2. The Mode Register may be loaded prior to the AUTO REFRESH cycles if desired.
3. Outputs are guaranteed High-Z after command is issued.

POWER-DOWN MODE [1]



TIMING PARAMETERS

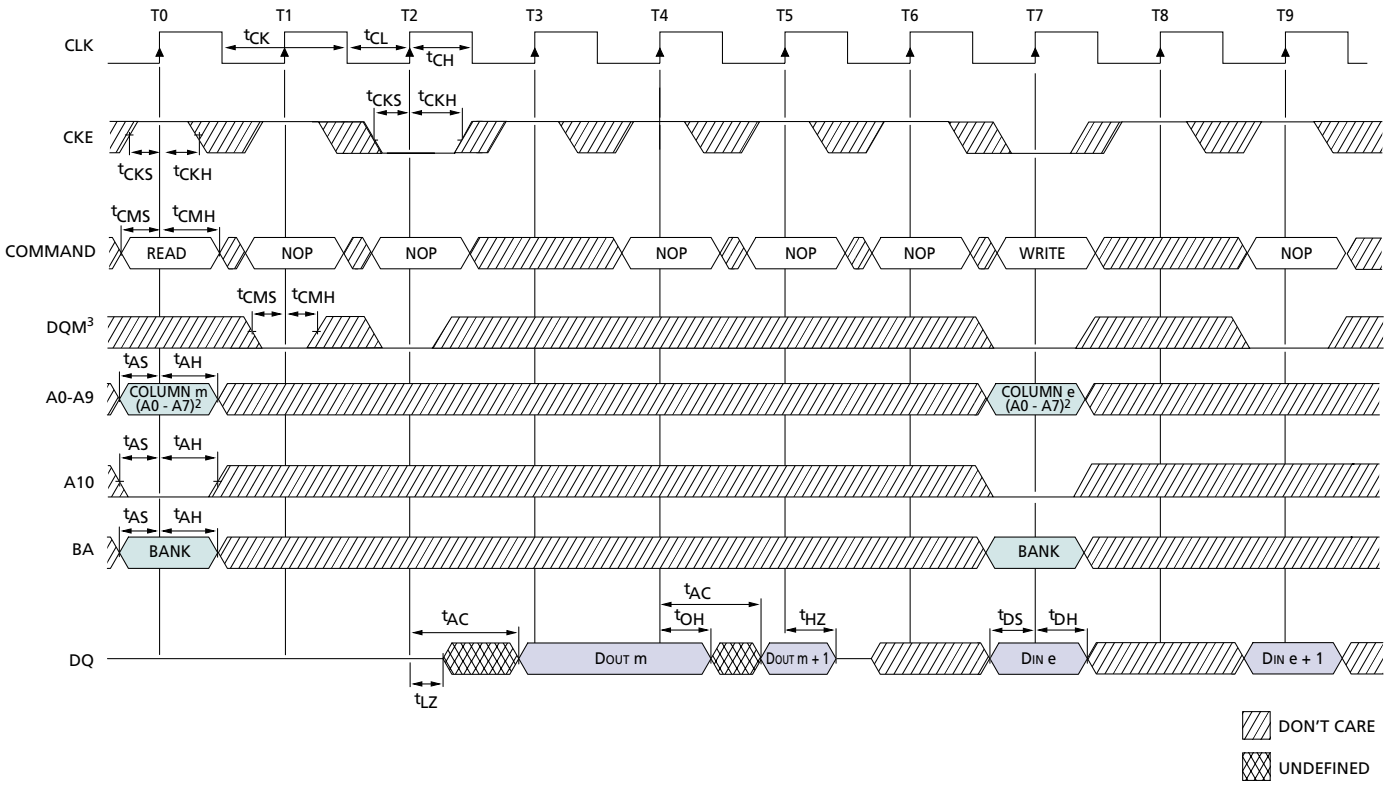
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns

*CAS latency indicated in parentheses.

NOTE: 1. Violating refresh requirements during power-down may result in loss of data.
2. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

CLOCK SUSPEND MODE [1]



TIMING PARAMETERS

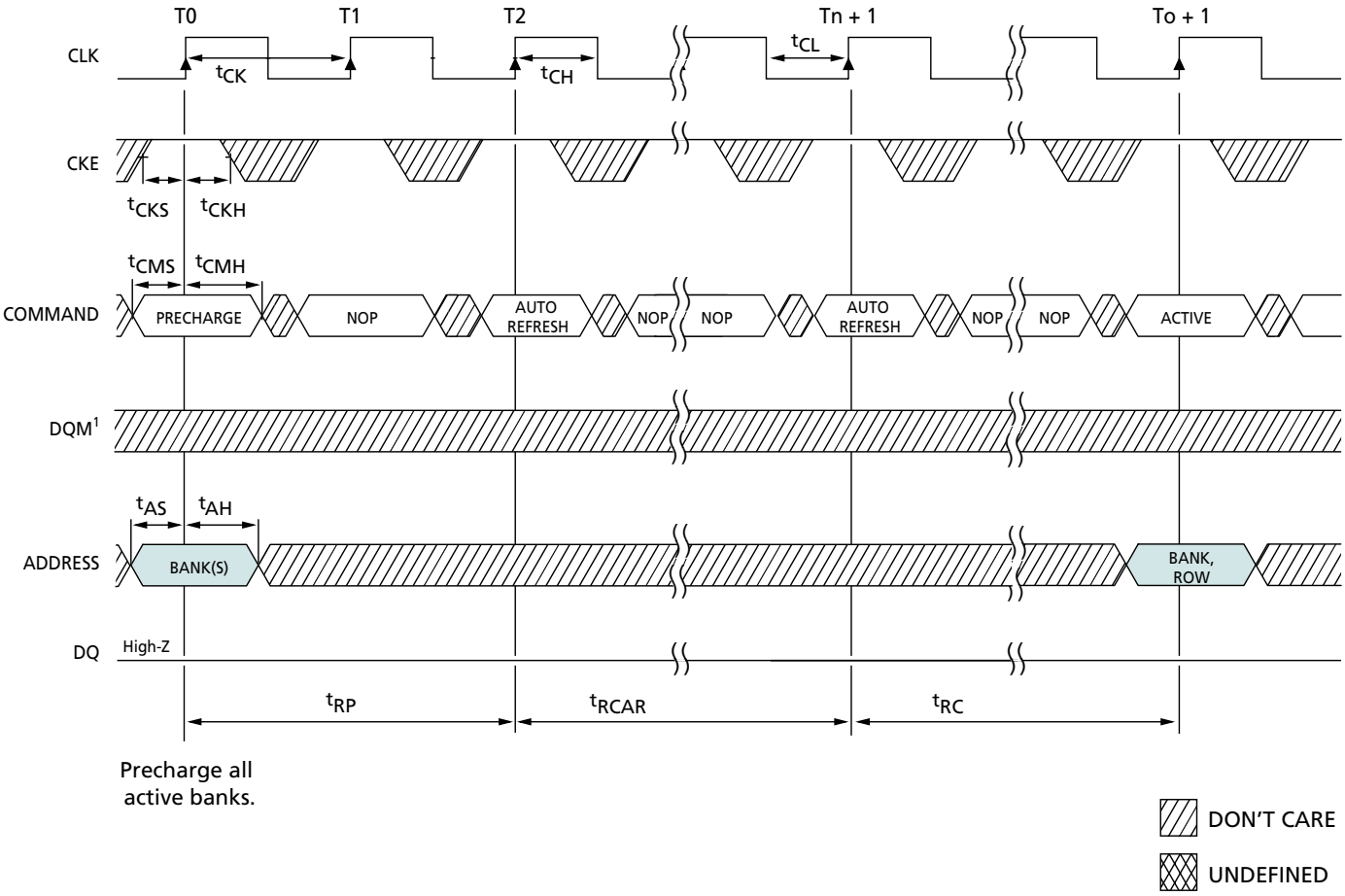
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAC (3)		5.5		5.5		6	ns
tAC (2)		8		8.5		9	ns
tAC (1)		18		22		22	ns
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tDH	1		1		1		ns
tDS	2		2		2		ns
tHZ (3)		5.5		5.5		6	ns
tHZ (2)		8		8.5		9	ns
tHZ (1)		18		22		22	ns
tLZ	1		1		1		ns
tOH	2		2		2.5		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 2, the CAS latency = 3, and AUTO PRECHARGE is disabled.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

AUTO REFRESH MODE



TIMING PARAMETERS

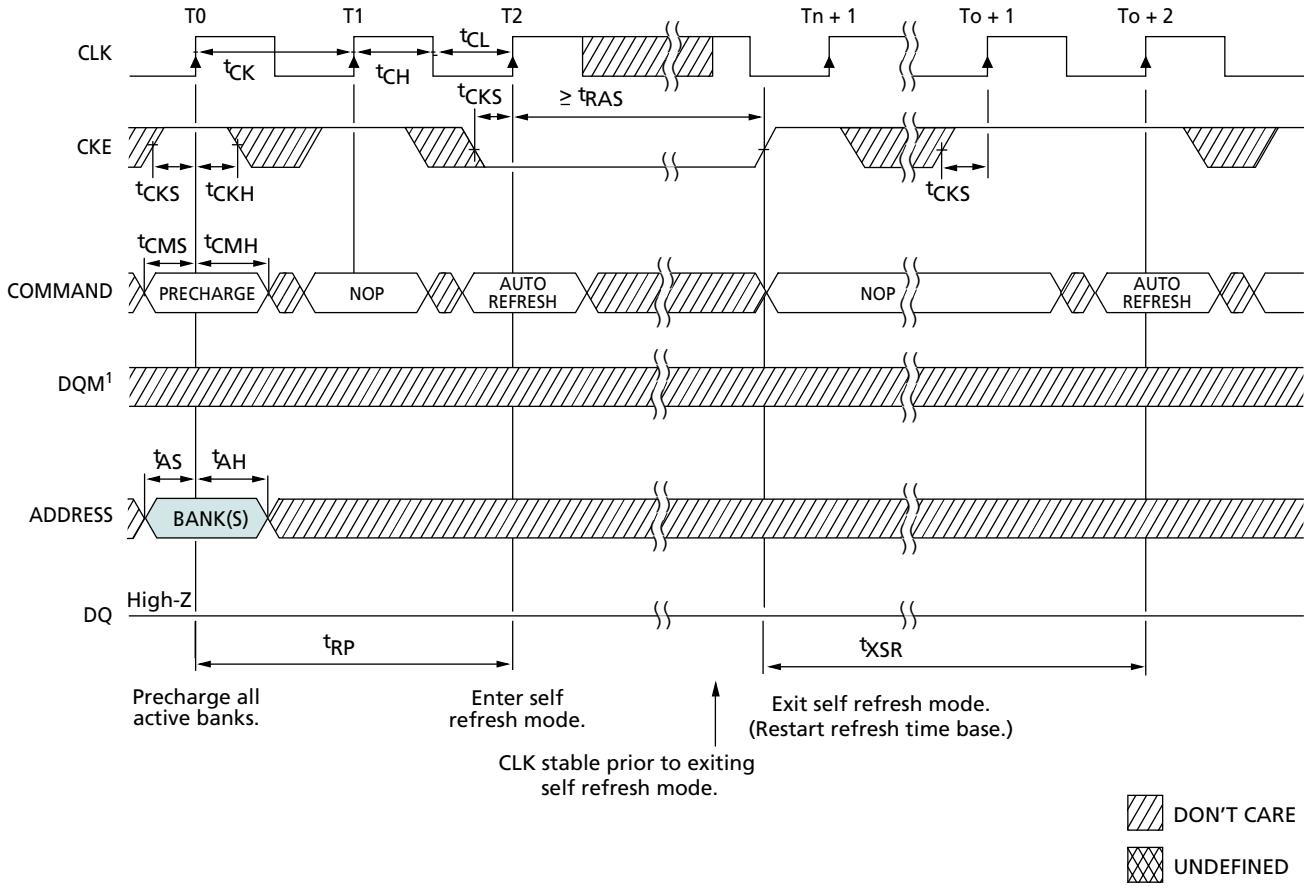
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tRC	60		70		80		ns
tRCAR	66		70		80		ns
tRP	18		21		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

SELF REFRESH MODE



TIMING PARAMETERS

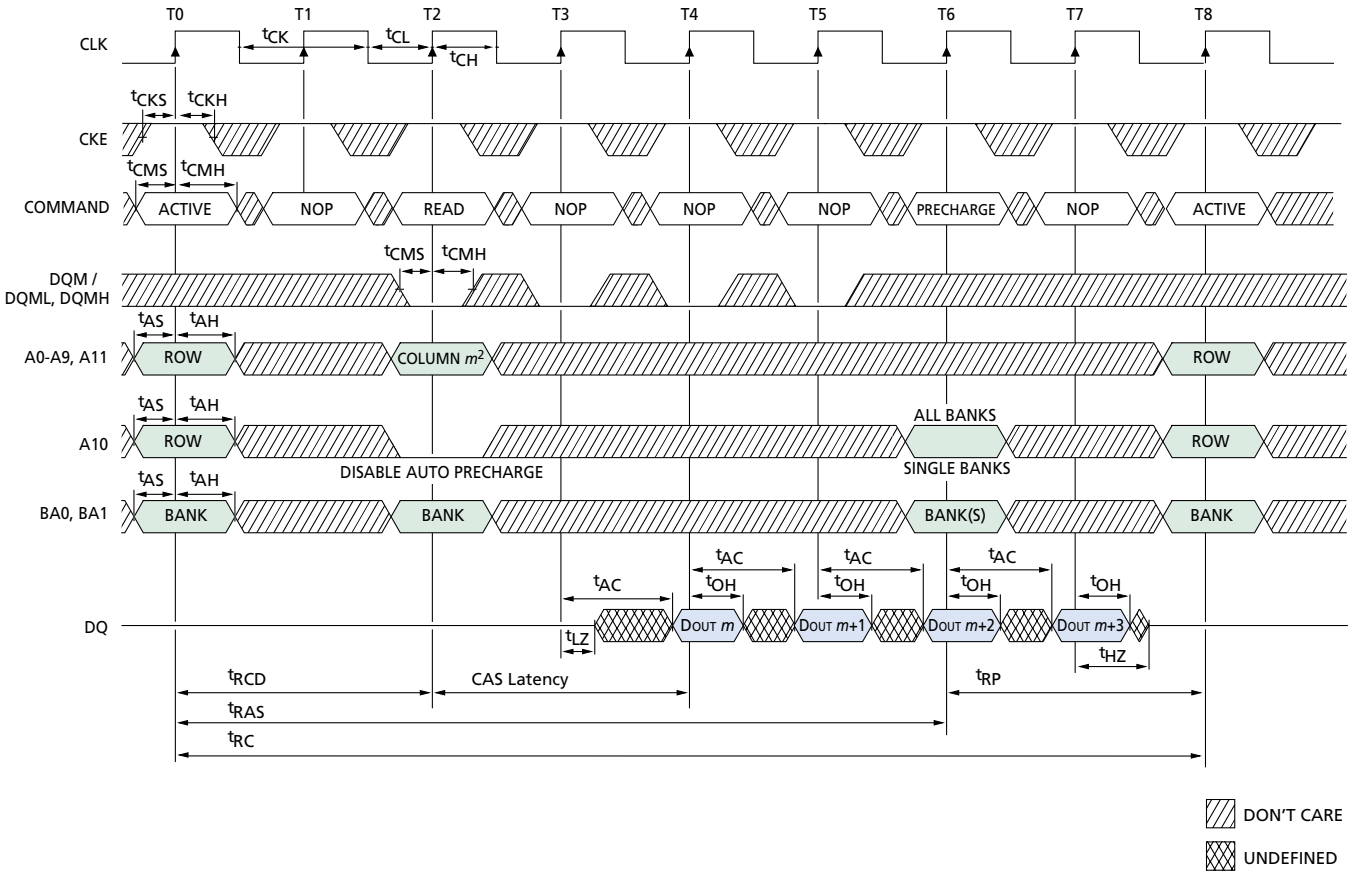
	-6		-7		-8A		
SYMBOL*	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns

	-6		-7		-8A		
SYMBOL*	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRP	18		21		24		ns
tXSR	80		80		80		ns

*CAS latency indicated in parentheses.

NOTE: 1. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

SINGLE READ – WITHOUT AUTO PRECHARGE [1]



TIMING PARAMETERS

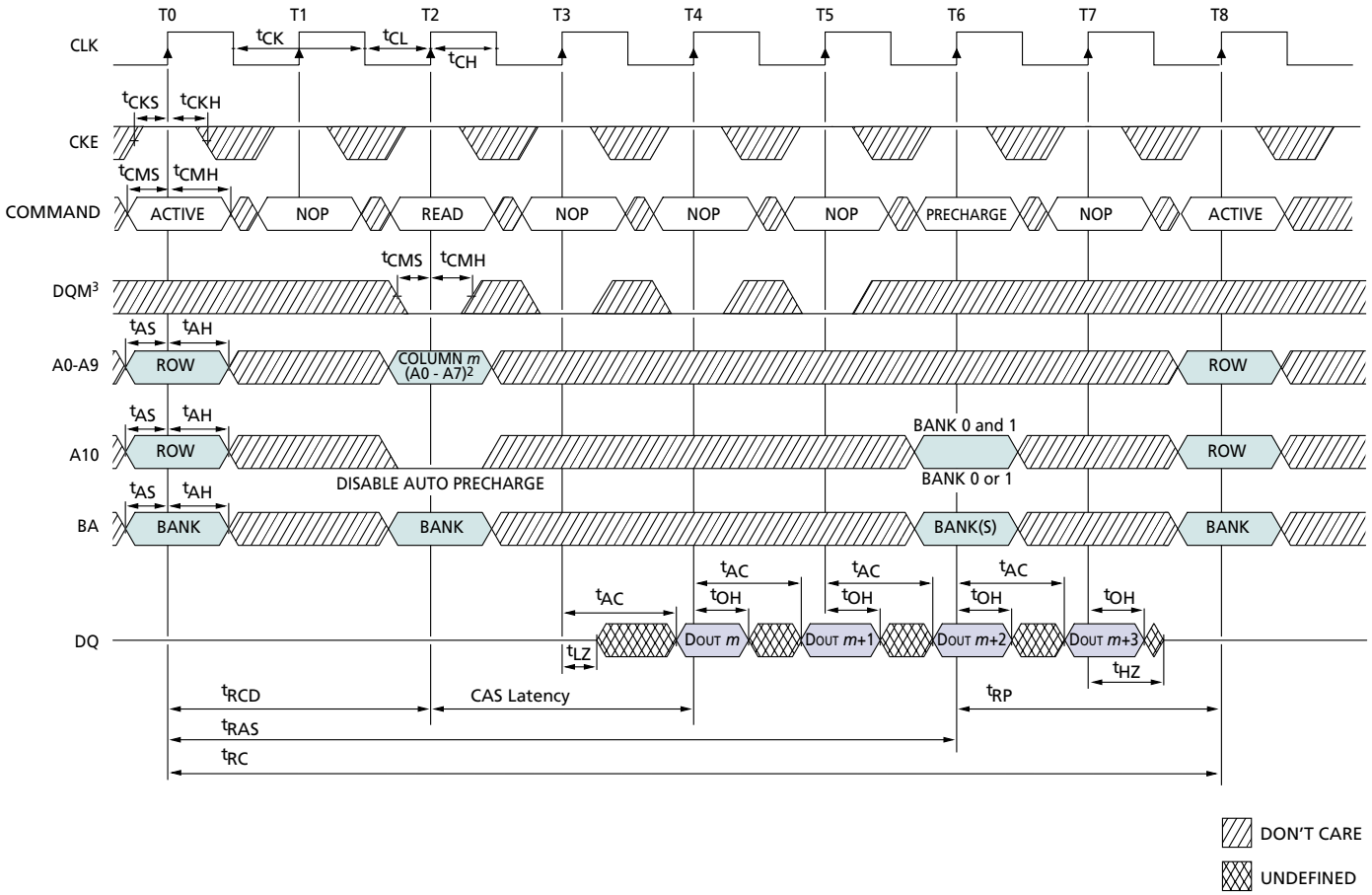
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAC (3)		5.5		5.5		6	ns
tAC (2)		8		8.5		9	ns
tAC (1)		18		22		22	ns
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tHZ (3)		5.5		5.5		6	ns
tHZ (2)		8		8.5		9	ns
tHZ (1)		18		22		22	ns
tLZ	1		1		1		ns
tOH	2		2		2.5		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4, the CAS latency = 2, and the READ burst is followed by a "manual" PRECHARGE.
2. A8, A9 = "Don't Care."

READ – WITHOUT AUTO PRECHARGE [1]



TIMING PARAMETERS

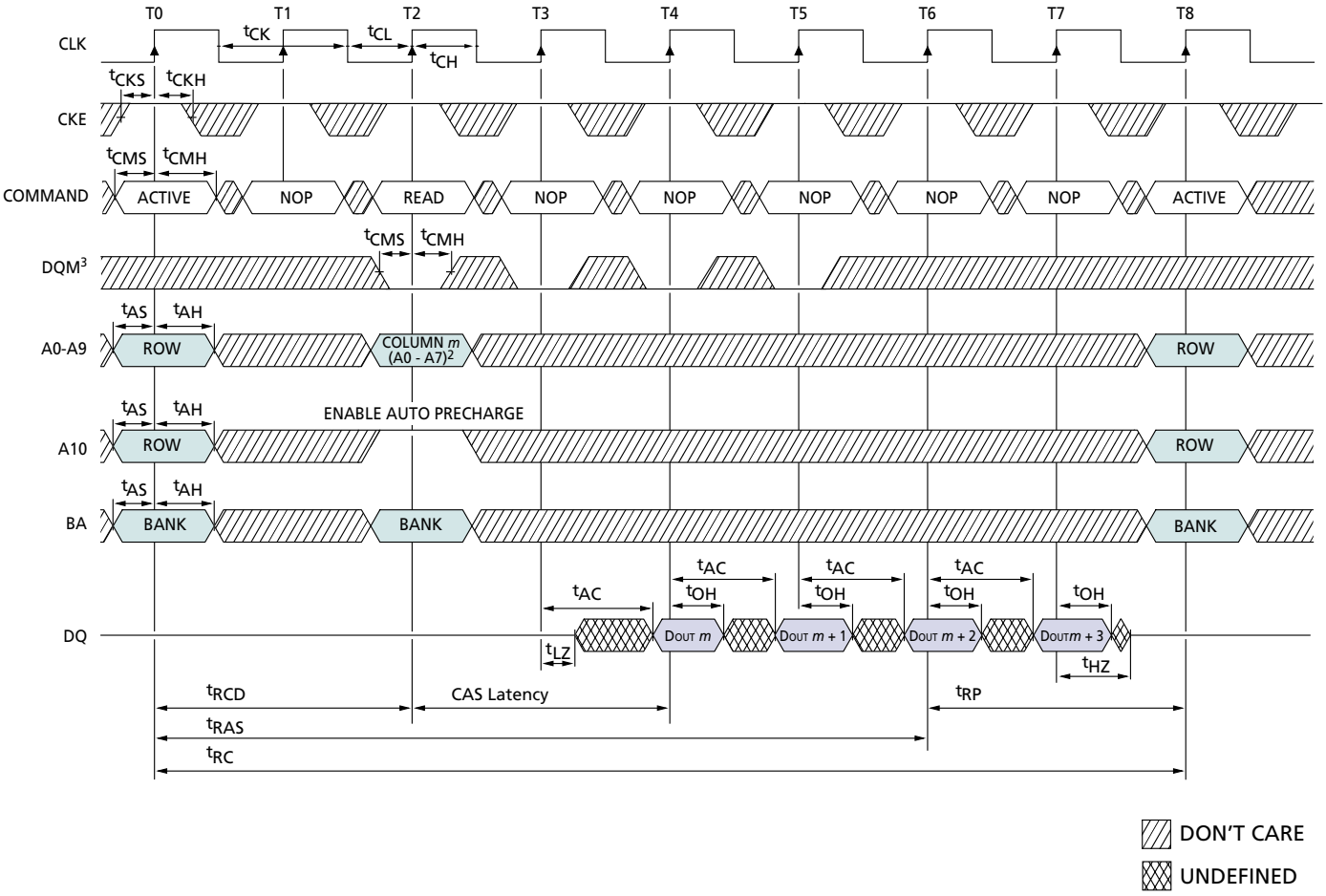
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAC (3)		5.5		5.5		6	ns
tAC (2)		8		8.5		9	ns
tAC (1)		18		22		22	ns
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tHZ (3)		5.5		5.5		6	ns
tHZ (2)		8		8.5		9	ns
tHZ (1)		18		22		22	ns
tLZ	1		1		1		ns
tOH	2		2		2.5		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4, the CAS latency = 2, and the READ burst is followed by a "manual" PRECHARGE.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

READ – WITH AUTO PRECHARGE [1]



TIMING PARAMETERS

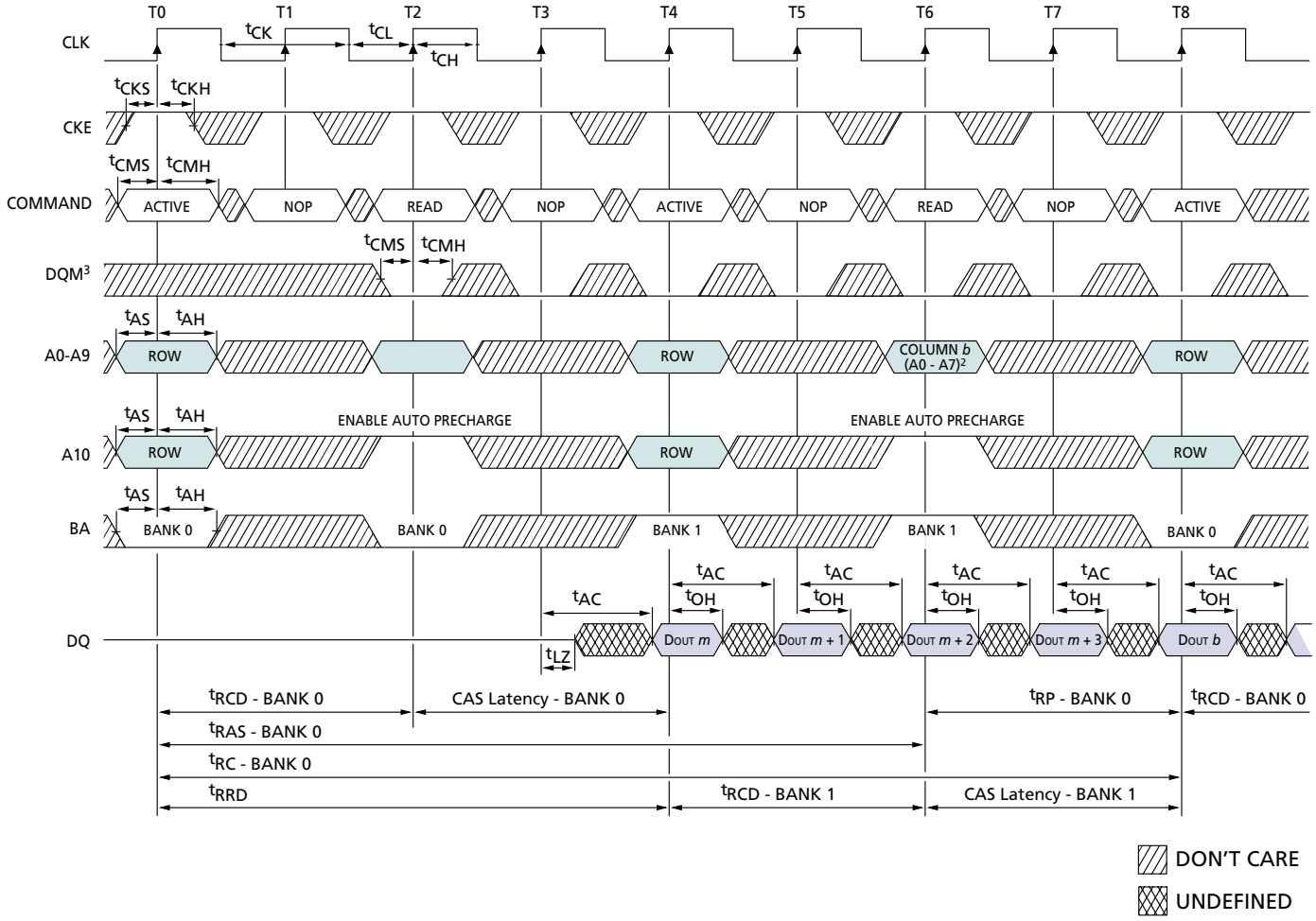
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAC (3)		5.5		5.5		6	ns
tAC (2)		8		8.5		9	ns
tAC (1)		18		22		22	ns
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tHZ (3)		5.5		5.5		6	ns
tHZ (2)		8		8.5		9	ns
tHZ (1)		18		22		22	ns
tLZ	1		1		1		ns
tOH	2		2		2.5		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4, and the CAS latency = 2.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

ALTERNATING BANK READ ACCESSES [1]



TIMING PARAMETERS

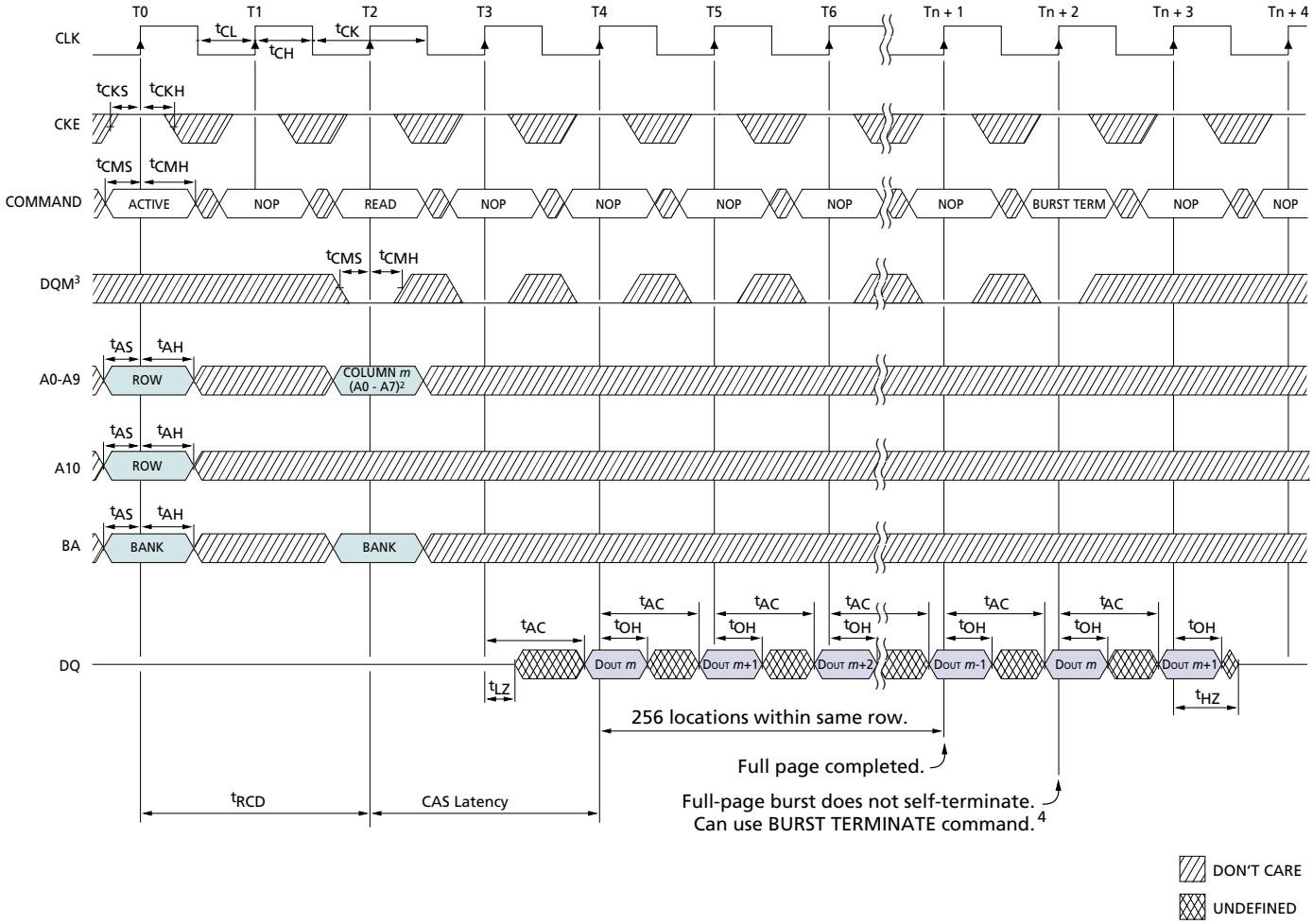
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAC (3)		5.5		5.5		6	ns
tAC (2)		8		8.5		9	ns
tAC (1)		18		22		22	ns
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tLZ	1		1		1		ns
tOH	2		2		2.5		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns
tRRD	12		14		16		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4, and the CAS latency = 2.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

READ – FULL-PAGE BURST [1]



TIMING PARAMETERS

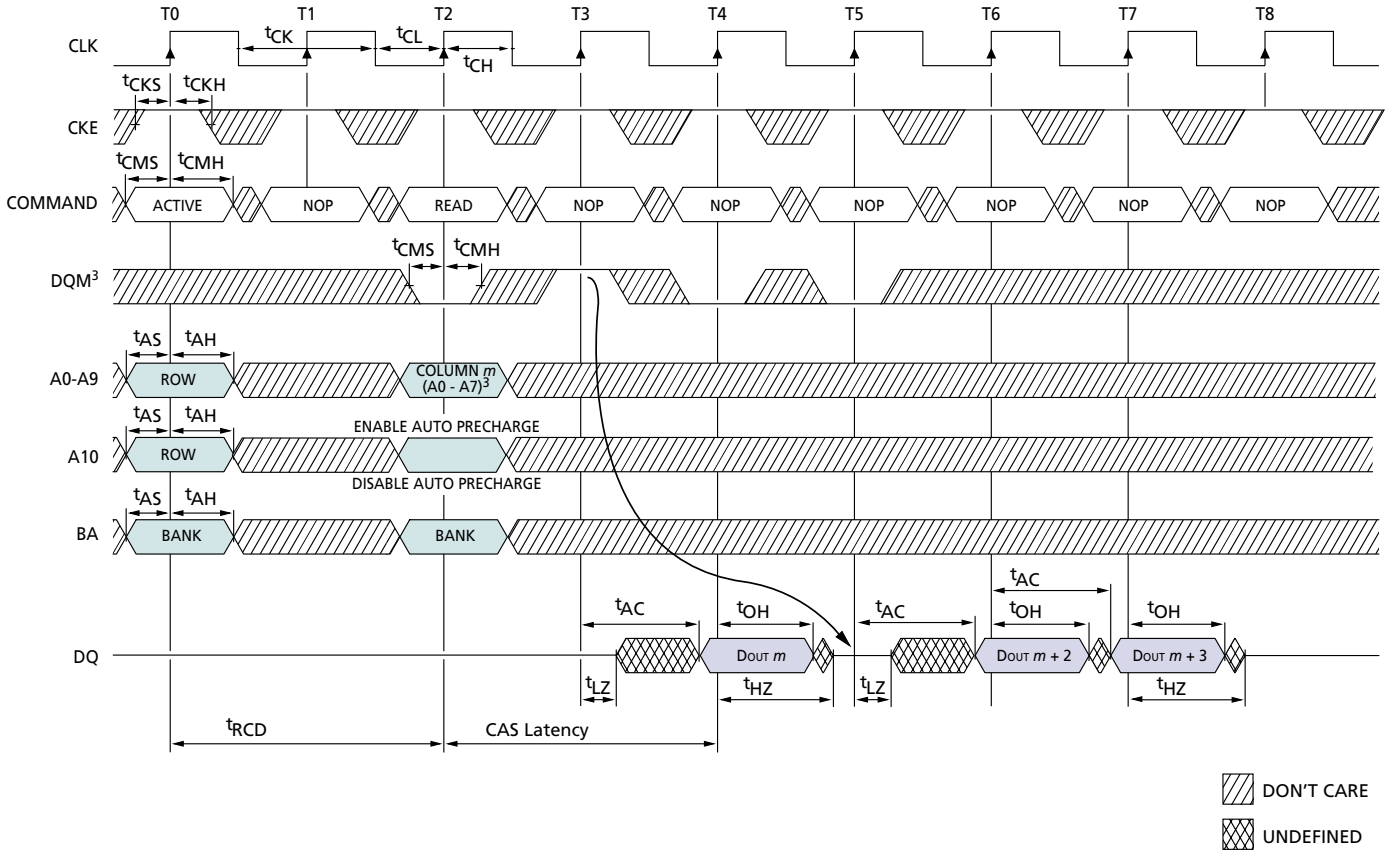
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAC (3)		5.5		5.5		6	ns
tAC (2)		8		8.5		9	ns
tAC (1)		18		22		22	ns
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tHZ (3)		5.5		5.5		6	ns
tHZ (2)		8		8.5		9	ns
tHZ (1)		18		22		22	ns
tLZ	1		1		1		ns
tOH	2		2		2.5		ns
tRCD	18		20		24		ns

*CAS latency indicated in parentheses.

NOTE:
1. For this example, the CAS latency = 2.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.
4. Page left open; no tRP.

READ – DQM OPERATION [1]



TIMING PARAMETERS

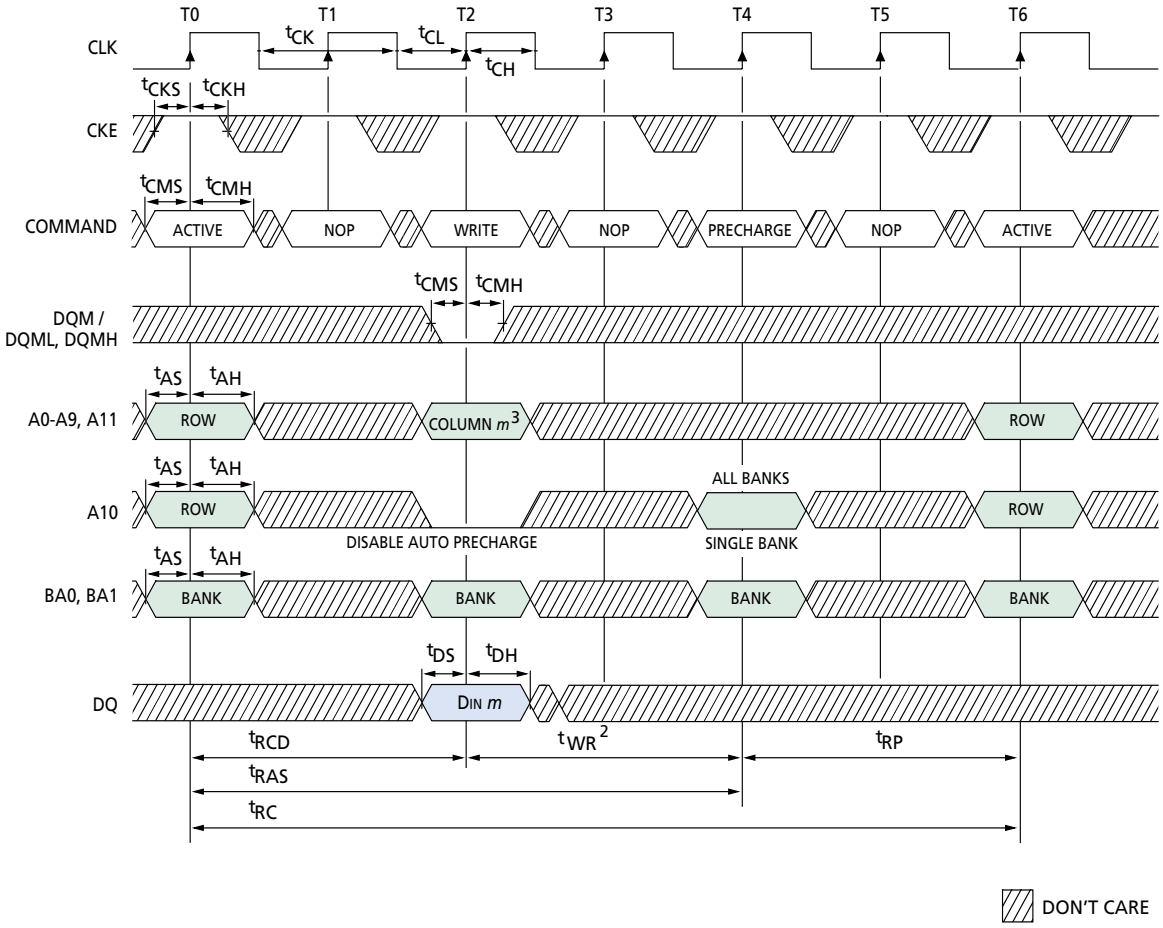
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAC (3)		5.5		5.5		6	ns
tAC (2)		8		8.5		9	ns
tAC (1)		18		22		22	ns
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tHZ (3)		5.5		5.5		6	ns
tHZ (2)		8		8.5		9	ns
tHZ (1)		18		22		22	ns
tLZ	1		1		1		ns
tOH	2		2		2.5		ns
tRCD	18		20		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4, and the CAS latency = 2.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

SINGLE WRITE – WITHOUT AUTO PRECHARGE [1]



TIMING PARAMETERS

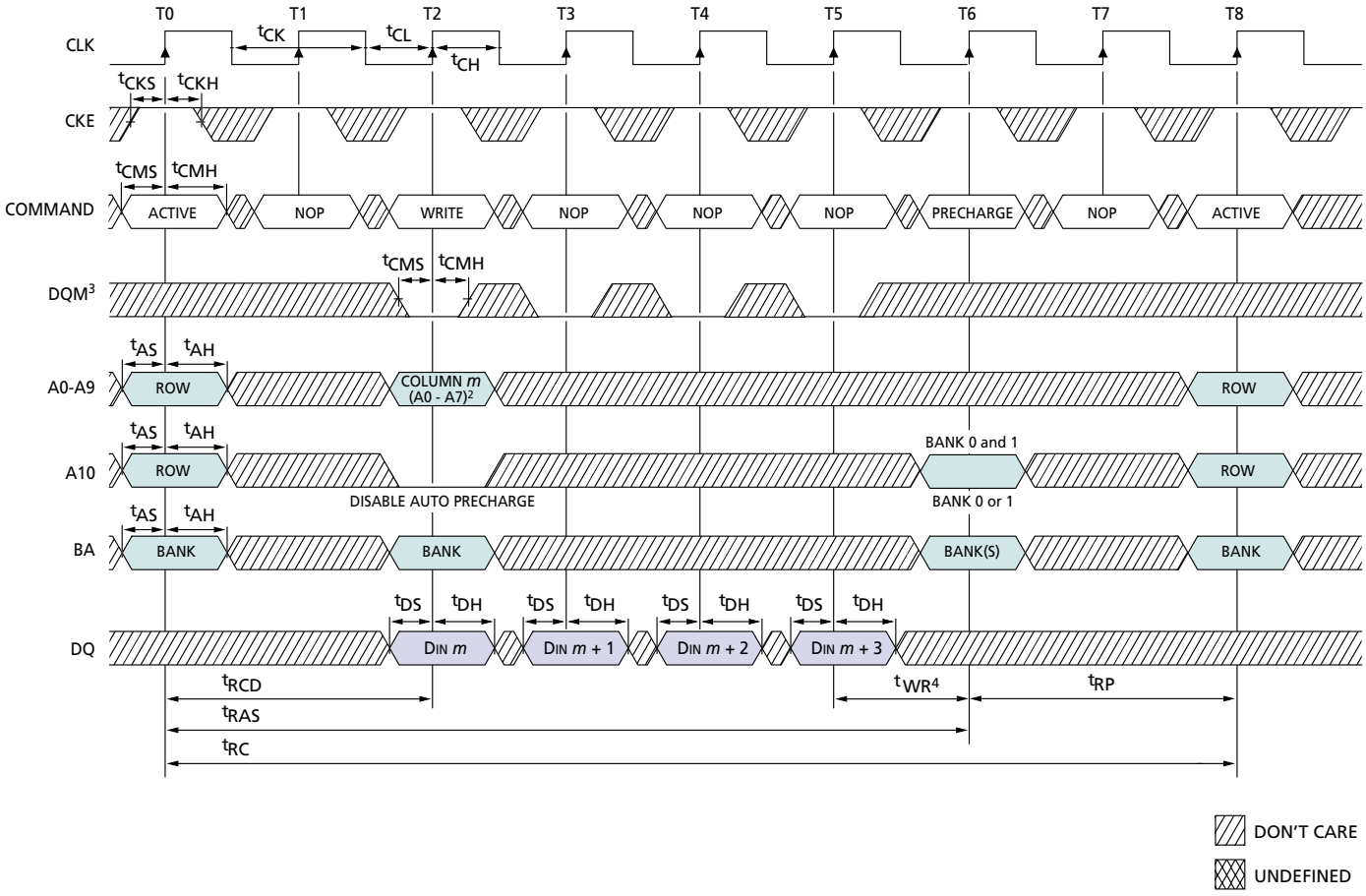
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tDH	1		1		1		ns
tDS	2		2		2		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns
tWR	10		10		10		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4, and the WRITE burst is followed by a "manual" PRECHARGE.
2. 10ns is required between <DIN m> and the PRECHARGE command, regardless of frequency, to meet tWR.
3. A8, A9 = "Don't Care."

WRITE – WITHOUT AUTO PRECHARGE [1]



TIMING PARAMETERS

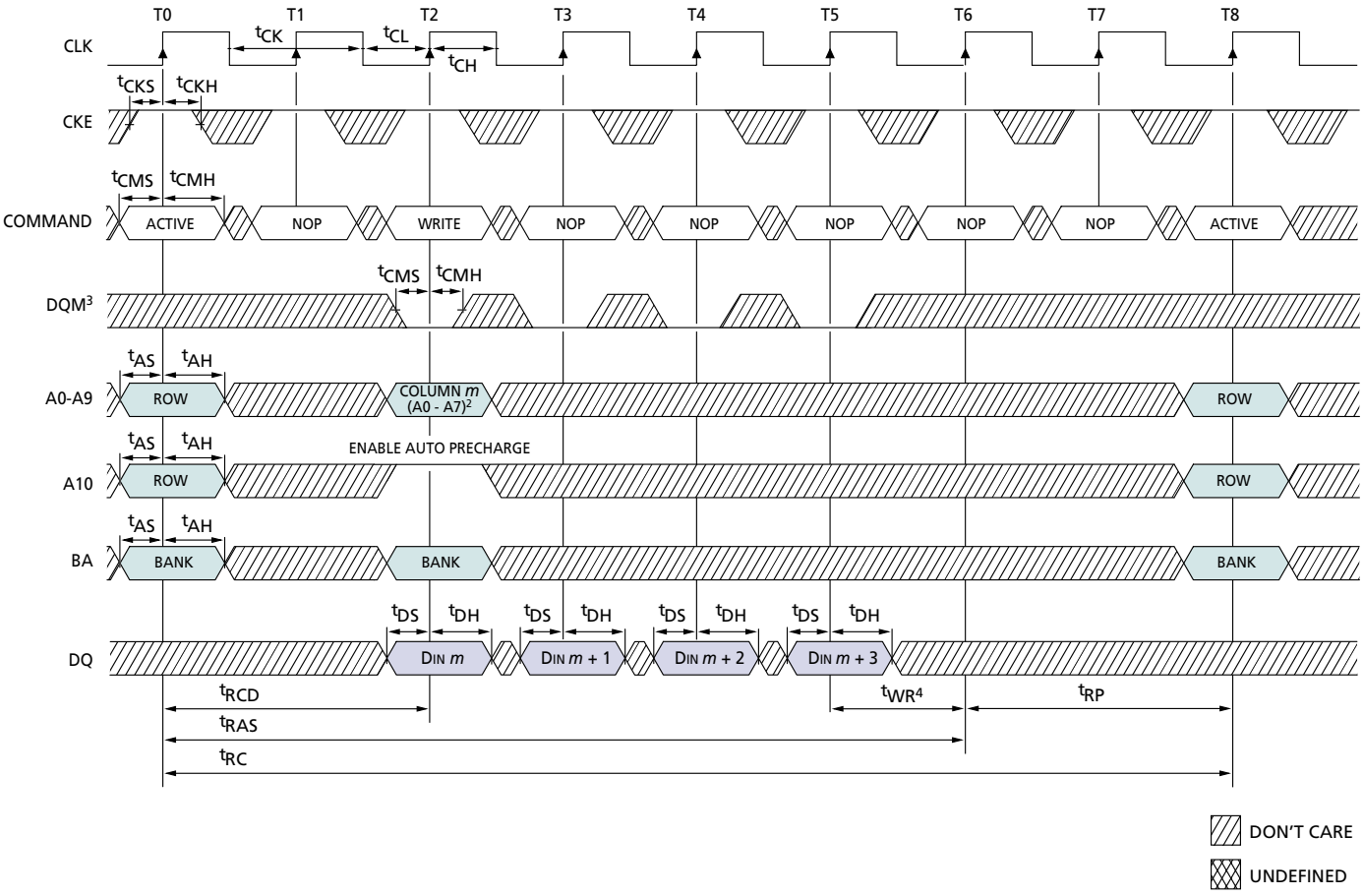
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tDH	1		1		1		ns
tDS	2		2		2		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns
tWR	10		10		10		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4, and the WRITE burst is followed by "manual" PRECHARGE.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.
4. Faster frequencies will require two clocks (when tWR > tCK).

WRITE – WITH AUTO PRECHARGE [1]



TIMING PARAMETERS

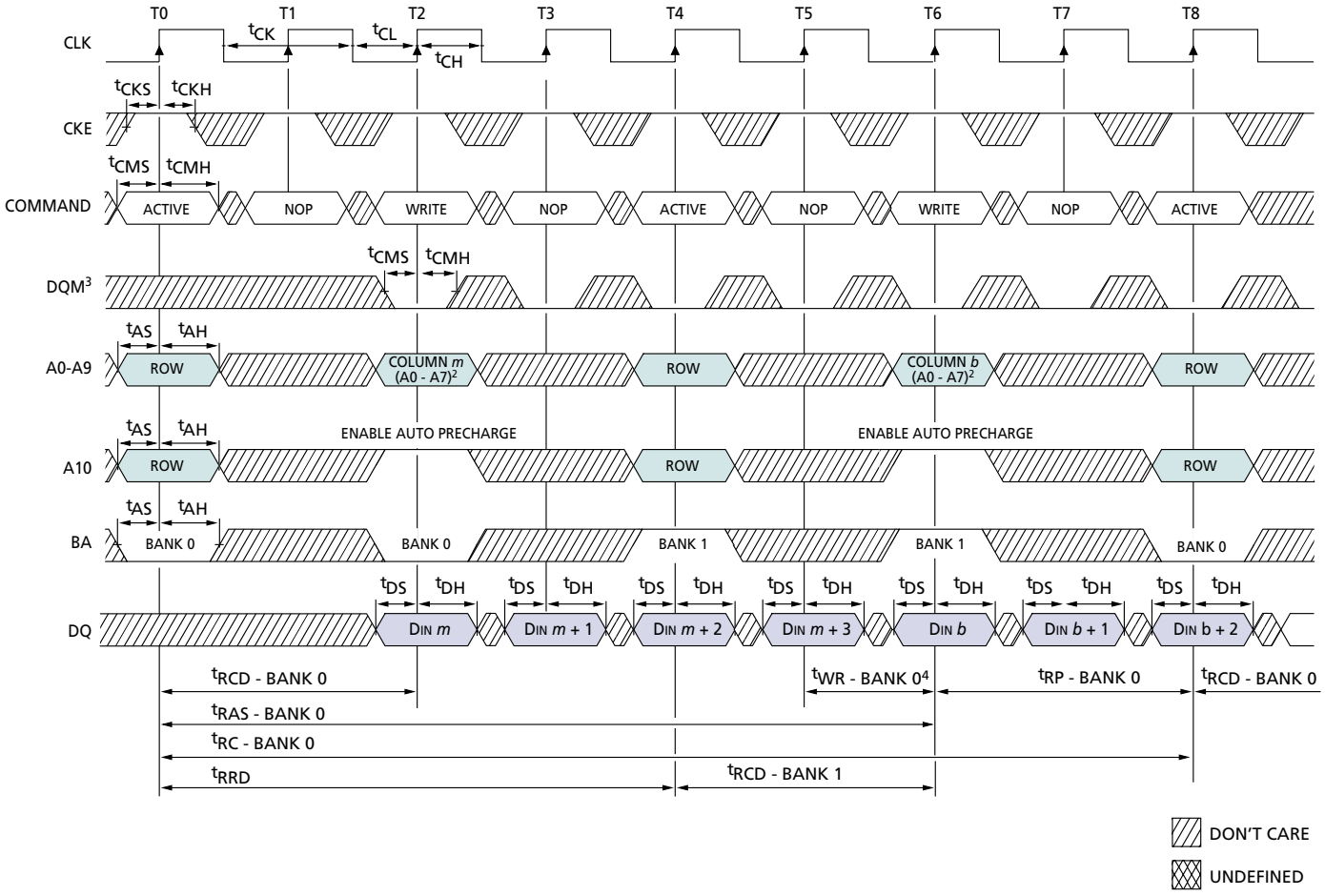
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tDH	1		1		1		ns
tDS	2		2		2		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns
tWR	1 + 4ns		1 + 3ns		1 + 2ns		tCK

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.
4. Faster frequencies will require two clocks (when tWR > tCK).

ALTERNATING BANK WRITE ACCESSES [1]



TIMING PARAMETERS

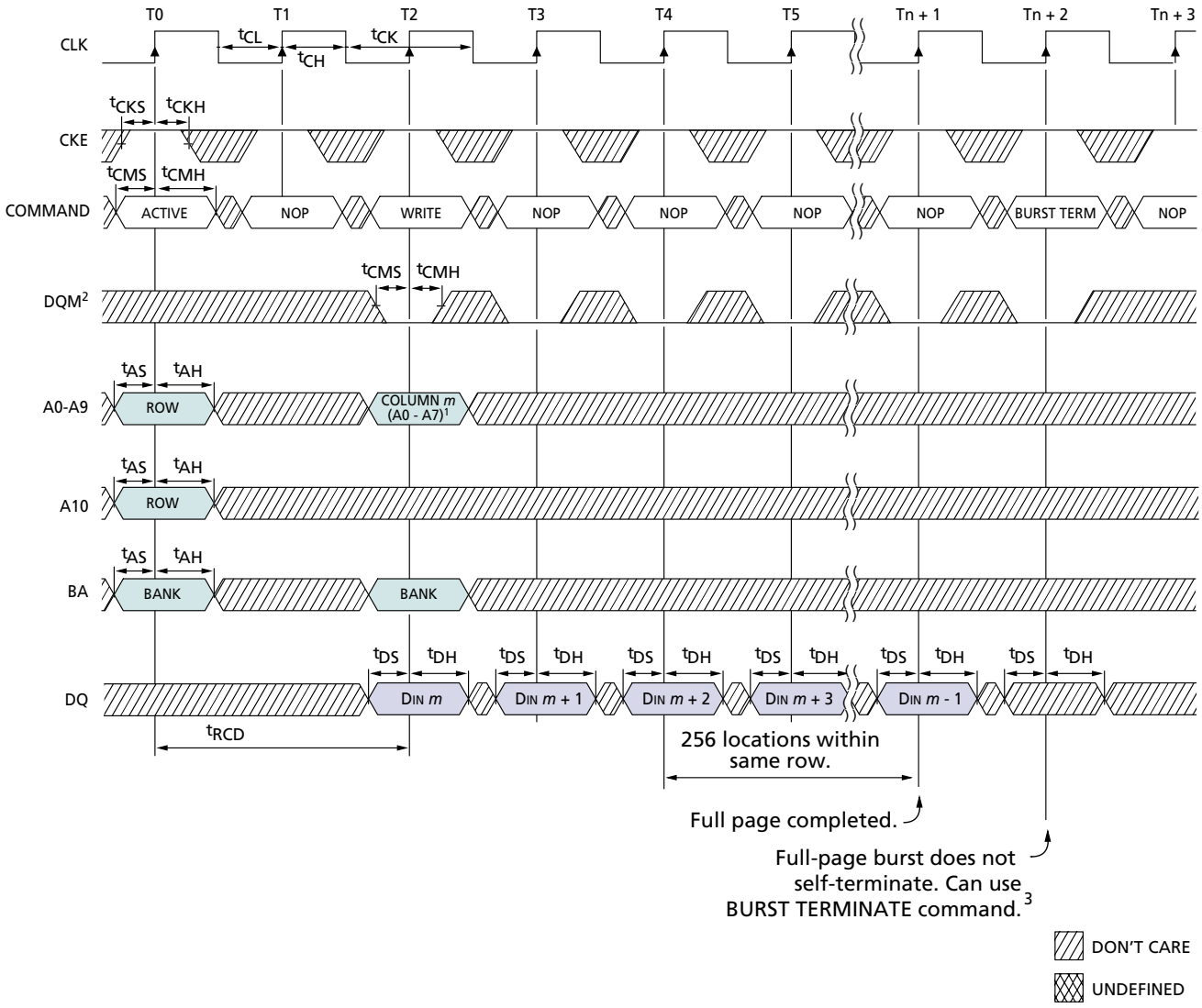
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCMS	2		2		2		ns
tDH	1		1		1		ns
tDS	2		2		2		ns
tRAS	42	120,000	42	120,000	48	120,000	ns
tRC	60		70		80		ns
tRCD	18		20		24		ns
tRP	18		21		24		ns
tRRD	12		14		16		ns
tWR	1 + 4ns		1 + 3ns		1 + 2ns		tCK

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.
4. Faster frequencies will require two clocks (when tWR > tCK).

WRITE – FULL-PAGE BURST



TIMING PARAMETERS

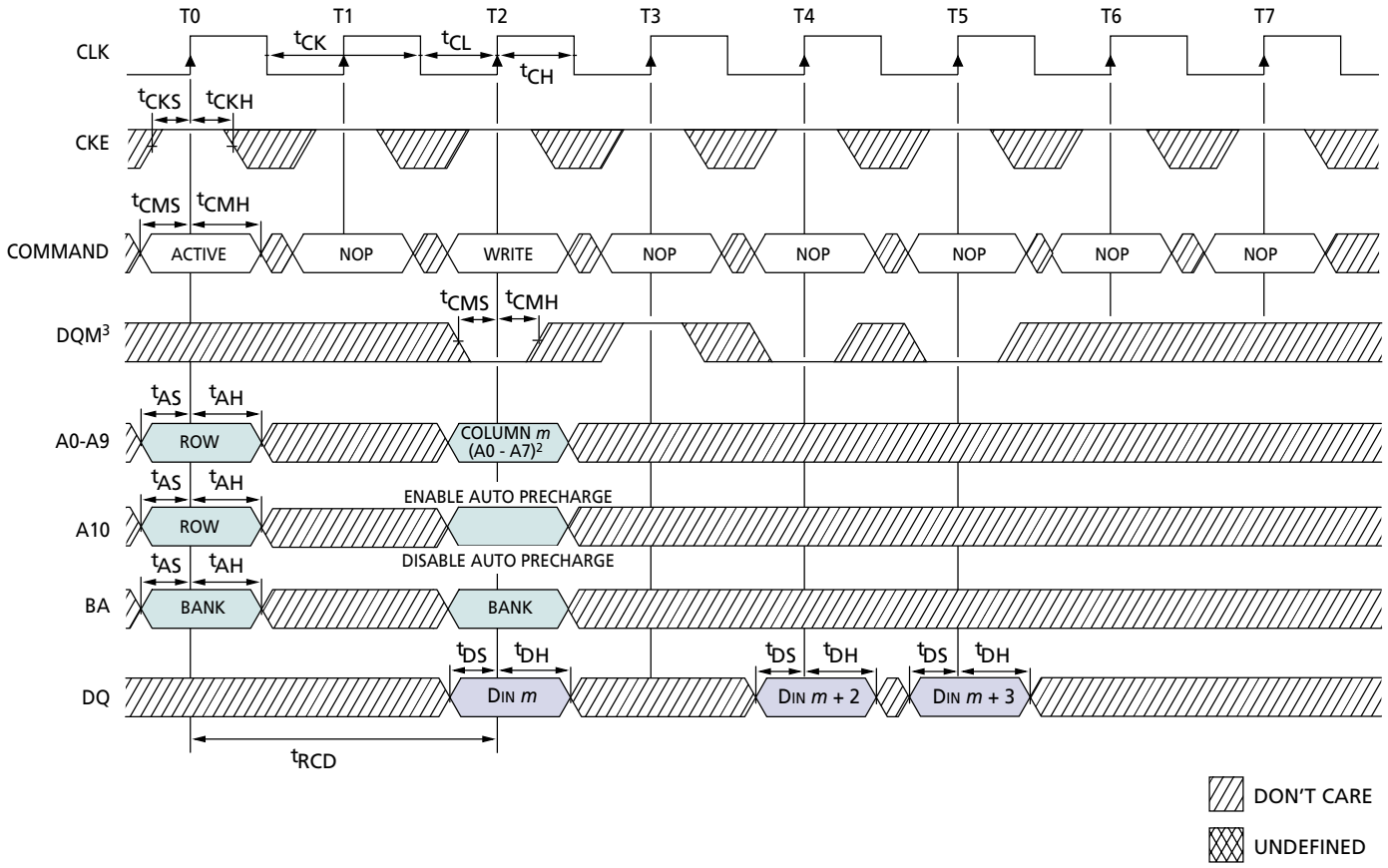
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tDH	1		1		1		ns
tDS	2		2		2		ns
tRCD	18		20		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. A8 and A9 = "Don't Care."
2. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.
3. Page left open; no tRP.

WRITE – DQM OPERATION [1]



TIMING PARAMETERS

SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tAH	1		1		1		ns
tAS	2		2		2		ns
tCH	2.5		2.75		3		ns
tCL	2.5		2.75		3		ns
tCK (3)	6		7		8		ns
tCK (2)	8		10		13		ns
tCK (1)	20		25		25		ns

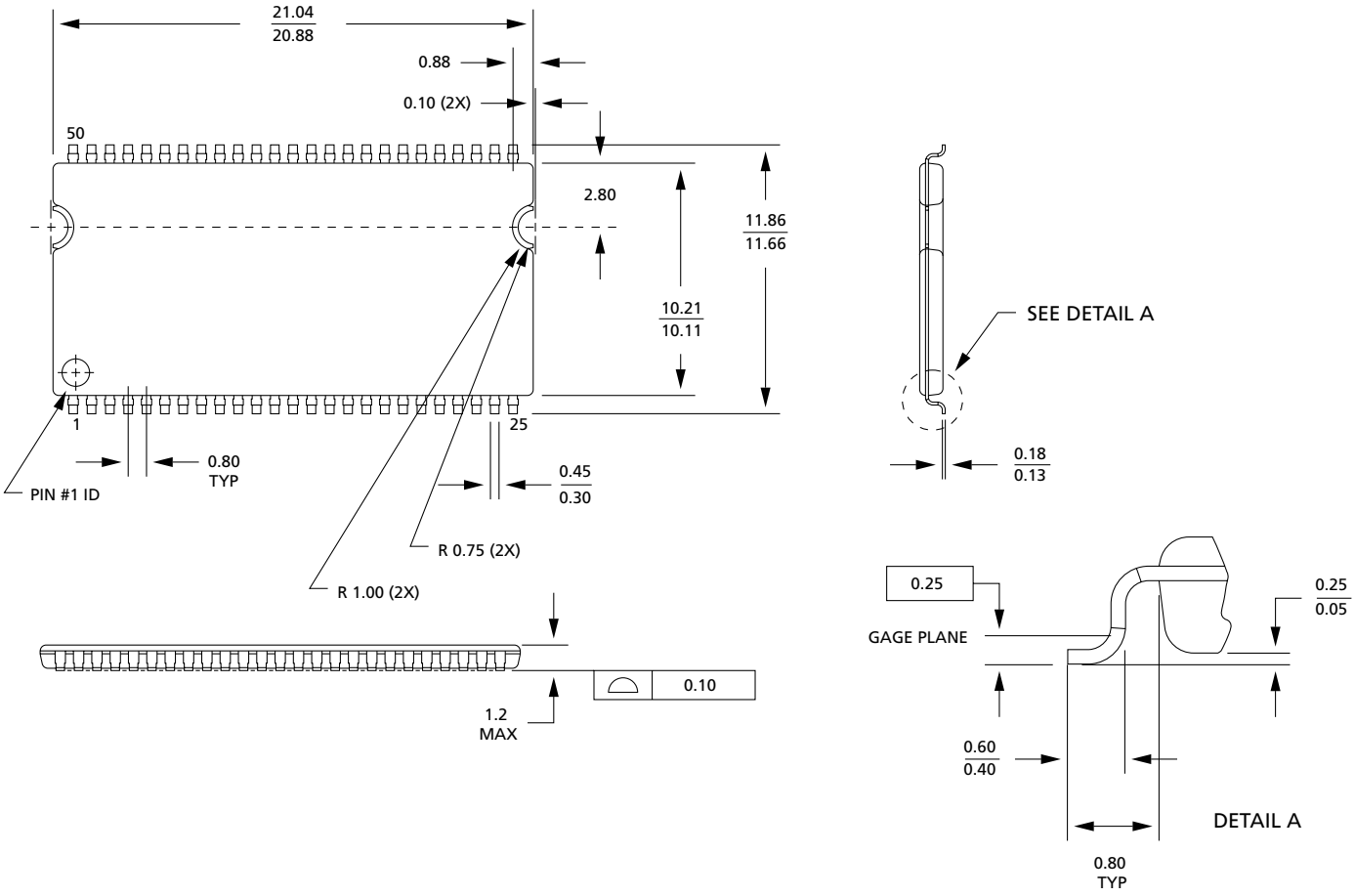
SYMBOL*	-6 MIN	-6 MAX	-7 MIN	-7 MAX	-8A MIN	-8A MAX	UNITS
tCKH	1		1		1		ns
tCKS	2		2		2		ns
tCMH	1		1		1		ns
tCMS	2		2		2		ns
tDH	1		1		1		ns
tDS	2		2		2		ns
tRCD	18		20		24		ns

*CAS latency indicated in parentheses.

NOTE: 1. For this example, the burst length = 4.
2. A8 and A9 = "Don't Care."
3. DQM represents DQML and DQMH. DQML controls the lower byte, and DQMH controls the upper byte.

50-PIN PLASTIC TSOP (400 mil)

C-4



NOTE: 1. All dimensions in millimeters $\frac{\text{MAX}}{\text{MIN}}$ or typical where noted.

2. Package width and length do not include mold protrusion; allowable mold protrusion is 0.01" per side.

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